



# TPS2384 Quad Integrated Power Sourcing Equipment Power Manager

## 1 Features

- Quad-Port Power Management With Integrated Switches and Sense Resistors
- Compliant to IEEE 802.3af Standard
- Operates from a Single 48-V Input Supply
- Individual Port 15-bit A/D
- Auto, Semi-Auto and Power Management Operating Modes
- Controlled Current Ramps for Reduced EMI and Charging of PD's Bulk Capacitance
- I<sup>2</sup>C Clock and Oscillator Watchdog Timers
- Over-Temperature Protection
- DC and DC Modulated Disconnect
- Supports Legacy Detection for Non-Compliant PD's
- Supports AC Disconnect
- High-Speed 400-kHz I<sup>2</sup>C Interface
- Comprehensive Power Management Software Available
- Operating Temperature Range –40°C to 125°C

## 2 Applications

- Ethernet Enterprise Switches
- Ethernet Hubs
- SOHO Hubs
- Ethernet Mid-Spans
- PSE Injectors

## 4 Typical Application

## 3 Description

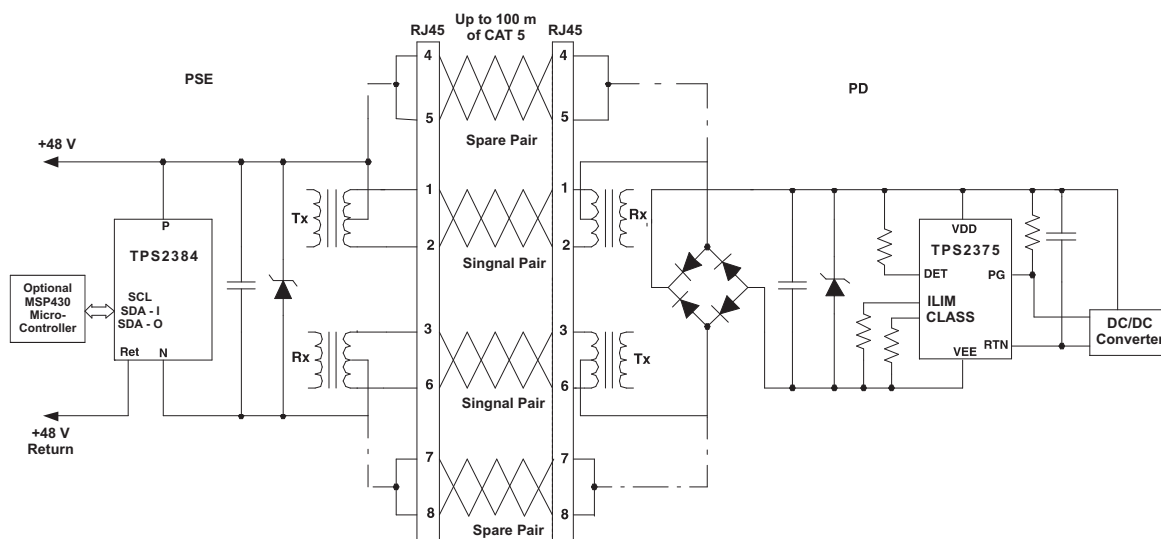
The TPS2384 is a quad-port power sourcing equipment power manager (PSEPM) and is compliant to the Power-over-Ethernet (PoE) IEEE 802.3af standard. The TPS2384 operates from a single 48-V supply and over a wide temperature range (–40°C to 125°C). The integrated output eliminates two external components per port (FET and sense resistor) and will survive 100-V transients. Four individual 15-bit A/D converters are used to measure port resistance, voltage, current and die temperature making PSE solutions simple and robust. The TPS2384 comes with a comprehensive software solution to meet the most demanding applications which can serve as a core for all PoE system designs.

The TPS2384 is available in either 64-pin PowerPAD™ down (PAP) or 64-pin PowerPAD™ up (PJD) packages.

### Device Information<sup>(1)</sup>

| PART NUMBER | PACKAGE    | BODY SIZE (NOM) |
|-------------|------------|-----------------|
| TPS2384     | HTQFP (64) | 10.0mm x 10.0mm |

(1) For all available packages, see the orderable addendum at the end of the data sheet.



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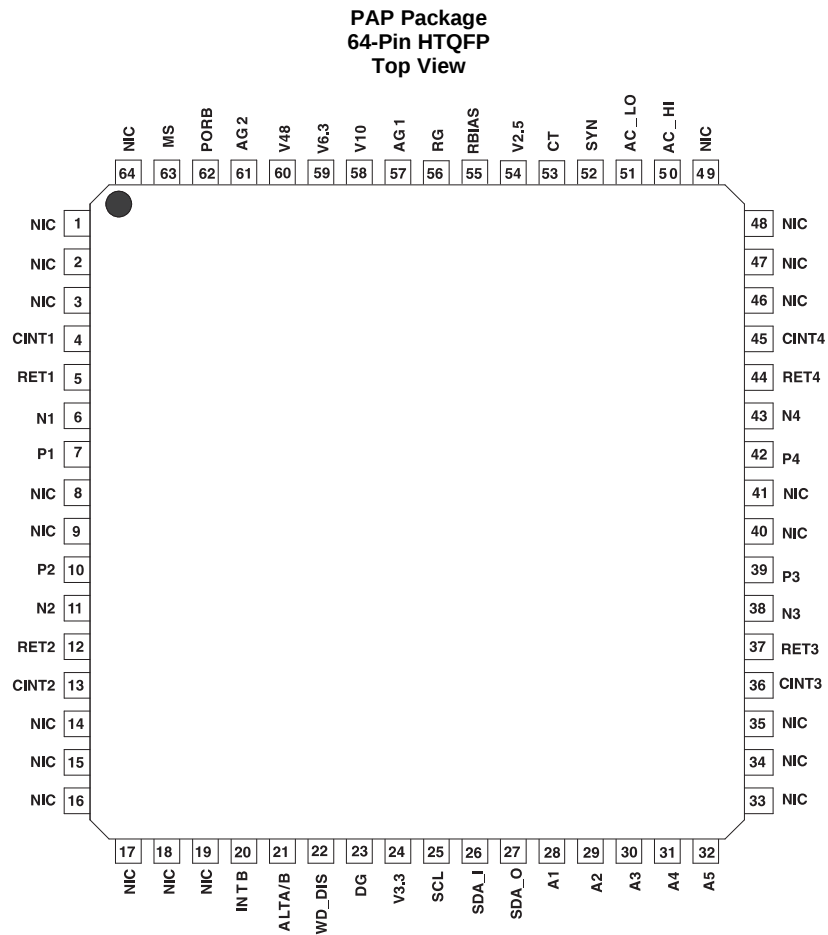
## 5 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

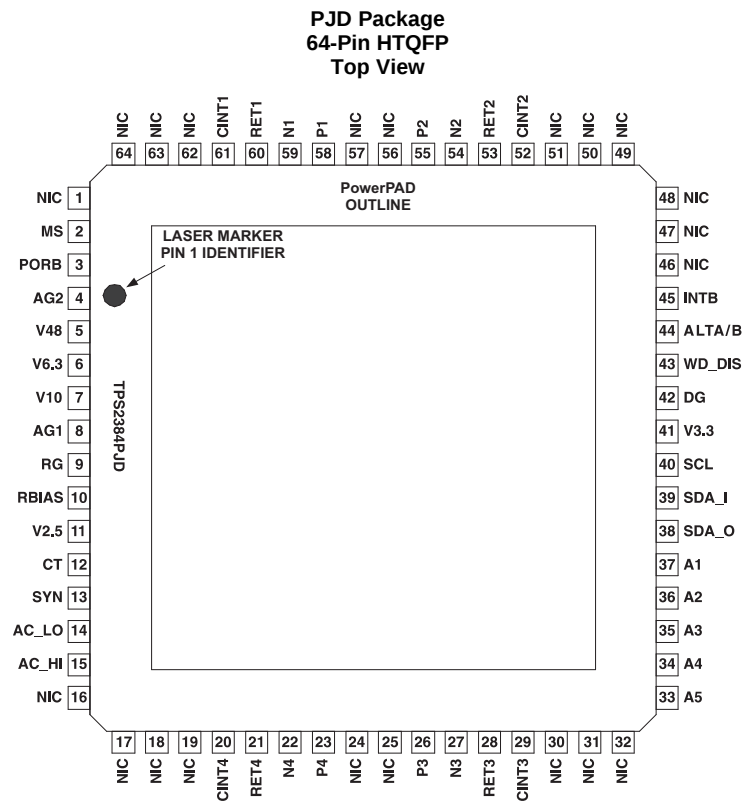
| Changes from Revision D (March 2007) to Revision E                                                                                                                                                                                                                                                                  | Page      |
|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------|
| • Added ESD Rating table, Thermal Information table Feature Description section, Device Functional Modes, Application and Implementation section, Power Supply Recommendations section, Layout section, Device and Documentation Support section, and Mechanical, Packaging, and Orderable Information section..... | <b>1</b>  |
| • Changed text in the description of pins A1-A5 From: "connecting to chip ground" To: "connecting to digital ground" .....                                                                                                                                                                                          | <b>6</b>  |
| • Changed the first 5 rows in the Digital I <sup>2</sup> C DC Specifications of the <i>Electrical Characteristics</i> .....                                                                                                                                                                                         | <b>9</b>  |
| • Added values for Discovery1,2 A/D conversion time in <i>Timing Requirements</i> TYP = 18, MAX = 22 ms.....                                                                                                                                                                                                        | <b>9</b>  |
| • Changed text in the <i>Auto Mode</i> From: "please contact the factory for additional application information." To: "refer to (SLUZ014)". .....                                                                                                                                                                   | <b>15</b> |
| • Changed text in <i>Start/Stop</i> from "and not used by the TPS2384." To: (See Note <sup>(1)</sup> in <i>Table 1</i> ) .....                                                                                                                                                                                      | <b>32</b> |
| • Changed text in the first sentence of <i>Chip Address</i> .....                                                                                                                                                                                                                                                   | <b>32</b> |
| • Added Note <sup>(1)</sup> to <i>Table 1</i> .....                                                                                                                                                                                                                                                                 | <b>33</b> |
| • Changed text in Note 2 of <i>Table 5</i> From: "Consult factory for Alternative B,." To: "refer to (SLUZ014) "for Alternative B,." .....                                                                                                                                                                          | <b>37</b> |
| • Changed text in Note 2 of <i>Table 7</i> From: "Consult factory for Alternative B,." To: "refer to (SLUZ014) "for Alternative B,." .....                                                                                                                                                                          | <b>38</b> |
| • Changed the connections to pins 50 and 51 in <i>Figure 40</i> .....                                                                                                                                                                                                                                               | <b>44</b> |

- (1) TPS2384 will acknowledge four slave address values for each setting of A5-A1 (A7,A6 = 00, 01, 10, 11). Slave devices sharing the bus with TPS2384(s) should use unique A5-A1 values not matching those of the TPS2384(s).

## 6 Pin Configuration and Functions



- (1) NIC = No internal connection. Pins are floating.
- (2) NIC pins can be tied to the ground plane for improved thermal characteristics and to prevent noise injection from unused pins.
- (3) NIC pins next to CINT pins should be tied to ground to prevent noise injection into A/D converter.



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### Pin Functions

| PIN                |     |     | I/O | DESCRIPTION                                                                                                                                                                                                                                                                                                                                                                   |
|--------------------|-----|-----|-----|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| NAME               | NO. |     |     |                                                                                                                                                                                                                                                                                                                                                                               |
|                    | PAP | PDJ |     |                                                                                                                                                                                                                                                                                                                                                                               |
| Power and Ground   |     |     |     |                                                                                                                                                                                                                                                                                                                                                                               |
| V48                | 60  | 5   | I   | 48-V input to the device. This supply can have a range of 44 to 57 V. This pin should be decoupled with a 0.1-μF capacitor from V48 to AG1 placed as close to the device as possible.                                                                                                                                                                                         |
| V10                | 58  | 7   | O   | 10-V analog supply. The 10-V reference is generated internally and connects to the main internal analog power bus. A 0.1-μF de-coupling capacitor should terminate as close to this node and the AG1 pin as possible. Do not use for an external supply.                                                                                                                      |
| V6.3               | 59  | 6   | O   | 6.3-V analog supply. A 0.1-μF de-coupling capacitor should terminate as close to this pin and the AG1 pin as possible. Do not use for an external supply.                                                                                                                                                                                                                     |
| V3.3               | 24  | 41  | O   | 3.3-V logic supply. The 3.3-V supply is generated internally and connects to the internal logic power bus. A 0.1-μF de-coupling capacitor should terminate as close to this node and the DG pin as possible. This output can be used as a low current supply to external logic.                                                                                               |
| V2.5               | 54  | 11  | O   | 2.5-V reference supply. The V2.5 is generated internally and connects to the internal reference power bus. This pin should not be tied to any external supplies. A 0.1-μF de-coupling capacitor should terminate as close to this node and the RG pin as possible. Do not use for an external supply.                                                                         |
| AG1                | 57  | 8   | GND | Analog ground 1. This is the analog ground of the V6.3, V10 and V48 power systems. It should be externally tied to the common copper 48-V return plane. This pin should carry the low side of three de-coupling capacitors tied to V48, V10 and V6.3.                                                                                                                         |
| AG2                | 61  | 4   | GND | Analog ground 2. This is the analog ground which ties to the substrate and ESD structures of the device. It should be externally tied to the common copper 48-V return plane. AG1 and AG2 must be tied together directly for the best noise immunity.                                                                                                                         |
| DG                 | 23  | 42  | GND | Digital ground. This pin connects to the internal logic ground bus. It should be externally tied to the common copper 48-V return plane.                                                                                                                                                                                                                                      |
| RG                 | 56  | 9   | GND | Reference ground. This is a precision sense of the external ground plane. The integration capacitor (CINT) and the biasing resistor (RBIAS pin) should be tied to this ground. This ground should also be used to form a printed wiring board ground guard ring around the active node of the integration capacitor (CINT). It should tie to common copper 48-V return plane. |
| Port Analog Signal |     |     |     |                                                                                                                                                                                                                                                                                                                                                                               |
| P1                 | 7   | 58  | I   | Port Positive. 48-V load sense pin. Terminal voltage is monitored and controlled differentially with respect to each Port N pin. Optionally, if the application warrants, this high-side path can be protected with the use of a self-resetting poly fuse.                                                                                                                    |
| P2                 | 10  | 55  | I   |                                                                                                                                                                                                                                                                                                                                                                               |
| P3                 | 39  | 26  | I   |                                                                                                                                                                                                                                                                                                                                                                               |
| P4                 | 42  | 23  | I   |                                                                                                                                                                                                                                                                                                                                                                               |
| N1                 | 6   | 59  | I   | Port negative. 48-V load return pin. The low side of the load is switched and protected by internal circuitry that limits the current.                                                                                                                                                                                                                                        |
| N2                 | 11  | 54  | I   |                                                                                                                                                                                                                                                                                                                                                                               |
| N3                 | 38  | 27  | I   |                                                                                                                                                                                                                                                                                                                                                                               |
| N4                 | 43  | 22  | I   |                                                                                                                                                                                                                                                                                                                                                                               |
| RET1               | 5   | 60  | I   | 48 V return pin.                                                                                                                                                                                                                                                                                                                                                              |
| RET2               | 12  | 53  | I   |                                                                                                                                                                                                                                                                                                                                                                               |
| RET3               | 37  | 28  | I   |                                                                                                                                                                                                                                                                                                                                                                               |
| RET4               | 44  | 21  | I   |                                                                                                                                                                                                                                                                                                                                                                               |
| CINT1              | 4   | 61  | I   | Integration capacitor This capacitor is used for the ramp A/D converter signal integration. Connect A 0.027- μF capacitor from this pin to RG. To minimize errors use a polycarbonate, poly-polypropylene, polystyrene or teflon capacitor type to prevent leakage. Other types of capacitors can be used with increased conversion error.                                    |
| CINT2              | 13  | 52  | I   |                                                                                                                                                                                                                                                                                                                                                                               |
| CINT3              | 36  | 29  | I   |                                                                                                                                                                                                                                                                                                                                                                               |
| CINT4              | 45  | 20  | I   |                                                                                                                                                                                                                                                                                                                                                                               |

### Pin Functions (continued)

| PIN             |     | I/O | DESCRIPTION |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
|-----------------|-----|-----|-------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| NAME            | NO. |     |             |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
|                 | PAP |     |             | PDJ                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         |
| Analog Signals  |     |     |             |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| CT              | 53  | 12  | I           | This is a dual-purpose pin. When tied to an external capacitor this pin sets the internal clock. When the CT pin is grounded the SYN pin turns from a output to an input (see SYN pin description).<br><br>The timing capacitor and the resistor on the RBIAS pin sets the internal clock frequency of the device. This internal clock is used for the internal state machine, integrating A/D counters, POR time out, faults and delay timers of each port. Using a 220-pF capacitor for CT and a 124-kΩ resistor for RBIAS sets the internal clock to 245 kHz and ensure IEEE 802.3af compliance along with maximizing the rejection of 60-Hz line frequency noise from A/D measurements. |
| RBIAS           | 55  | 10  | I           | Bias set resistor. This resistor sets all precision bias currents within the chip. This pin will regulate to 1.25V (V2.5/2) when a resistor is connected between RBIAS and RG. This voltage and RBIAS generate a current which is replicated and used throughout the chip. This resistor also works in conjunction with the capacitors on CT and CINT to set internal timing values. The RBIAS resistor should be connected RG. RBIAS is a high impedance input and care needs to be taken to avoid signal injection from the SYN pin or I <sup>2</sup> C signals.                                                                                                                          |
| SYN             | 52  | 13  | I/O         | This is a dual purpose pin. When the CT pin is connected to a timing capacitor this output pin is a 0 V to 3.3V pulse of the internal clock which can be used to drive other TPS2384 SYN pins for elimination of a timing capacitor. When the CT pin is grounded this pin becomes an input pin that can be driven from a master TPS2384 or any other clock generator signal.                                                                                                                                                                                                                                                                                                                |
| AC_LO           | 51  | 14  | O           | Totem-pole output pin for AC Disconnect excitation.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         |
| AC_HI           | 50  | 15  | O           | Totem-pole output pin for AC Disconnect excitation.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         |
| Digital Signals |     |     |             |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| SCL             | 25  | 40  | I           | Serial clock input pin for the I <sup>2</sup> C interface.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                  |
| SDA_I           | 26  | 39  | I           | Serial data input pin for the I <sup>2</sup> C interface. When tied to the SDA_O pin, this connection becomes the standard bi-directional serial data line (SDA)                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                            |
| SDA_O           | 27  | 38  | O           | Serial data open drain output for the I <sup>2</sup> C interface. When tied to the SDA_I pin, this connection becomes the standard bi-directional serial data line (SDA). This is a open drain output that can directly drive opto-coupler.                                                                                                                                                                                                                                                                                                                                                                                                                                                 |
| WD_DIS          | 22  | 43  | I           | The WD_DIS pin disables the watchdog timer function when connected to 3.3 V. The pin has internal 50-kΩ resistor to digital ground. The watchdog timer monitors the I <sup>2</sup> C clock pin (SCL) and the internal oscillator activity in power management mode and only the internal oscillator activity in auto mode.                                                                                                                                                                                                                                                                                                                                                                  |
| INTB            | 20  | 45  | O           | This is an open-drain output that goes low if a fault condition occurs on any of the 4 ports.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               |
| ALTA/B          | 21  | 44  | I           | When this input is set to logic low there is no back-off time after a discovery failure. When this pin set to a logic high there is a back-off time (approximately 2 seconds) before initiating another discovery cycle. This pin has an internal 50-kΩ resistor pull-down to digital ground.                                                                                                                                                                                                                                                                                                                                                                                               |
| A1              | 28  | 37  | I           | Address 1 through 5 These are the I <sup>2</sup> C address select inputs. Select the appropriate binary address on these pins by connecting to digital ground for a logic low or tying to the V3.3 pin for a logic high. Each address line has an internal current source pull-down to digital ground.                                                                                                                                                                                                                                                                                                                                                                                      |
| A2              | 29  | 36  | I           |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| A3              | 30  | 35  | I           |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| A4              | 31  | 34  | I           |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| A5              | 32  | 33  | I           |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| MS              | 63  | 2   | I           | The MS pin selects either the auto mode (MS low) or the power management mode, PMM, (MS high). This pin can be held low for controller-less standalone applications. When MS is low and the POR timing cycle is complete the chip will sequentially <i>Discover</i> , <i>Classify</i> and <i>Power on</i> each port. When MS is set high the ports are controlled by register setting via the I <sup>2</sup> C bus. The MS pin has an internal 50-kΩ resistor pull-down to analog ground.                                                                                                                                                                                                   |
| PORB            | 62  | 3   | I           | This pin can be used to override the internal POR. When held low, the I <sup>2</sup> C interface, all the state machines, and registers are held in reset. When all internal and external supplies are within specification, and this pin is set to a logic high level, the POR delay will begin. The I <sup>2</sup> C interface and registers will become active within 70 μs of this event and communications to read or preset registers can begin. The reset delay for the remainder of the chip then extinguishes in 1 second. This pin has an internal 50-kΩ resistor pull-down to analog ground.                                                                                     |

## 7 Specifications

### 7.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted) <sup>(1)</sup> <sup>(2)</sup>

|                                                                                                           | MIN        | MAX | UNIT |
|-----------------------------------------------------------------------------------------------------------|------------|-----|------|
| V <sub>I0</sub> current sourced                                                                           | 100        | 100 | μA   |
| V <sub>3.3</sub> current sourced                                                                          | 5          | 5   | mA   |
| Applied voltage on CINT#, CT, RBIAS                                                                       | –0.5 to 10 | 10  | V    |
| Applied voltage on SCL_I, SDA_I, SDA_O, INTB, A1, A2, A3, A4, A5, MS, PORB, WD_DIS, ALT_A/B, AC_LO, AC_HI | –0.5       | 6   |      |
| Applied voltage on V48, P#, N#                                                                            | –0.5       | 80  |      |
| T <sub>J</sub> Junction operating temperature                                                             | –40        | 125 | °C   |
| T <sub>stg</sub> Storage temperature –55 to 150                                                           | –55        | 150 |      |

- (1) Stresses beyond those listed under *absolute maximum ratings* may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under *recommended operating conditions* is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) All voltages are with respect to GND. Currents are positive into, negative out of the specified terminal.

### 7.2 ESD Ratings

|                                            | VALUE                                                                          | UNIT  |
|--------------------------------------------|--------------------------------------------------------------------------------|-------|
| V <sub>(ESD)</sub> Electrostatic discharge | Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 <sup>(1)</sup>              | ±1500 |
|                                            | Charged-device model (CDM), per JEDEC specification JESD22-C101 <sup>(2)</sup> | ±100  |

- (1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.
- (2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

### 7.3 Recommended Operating Conditions

|                                     | MIN | TYP | MAX | UNIT |
|-------------------------------------|-----|-----|-----|------|
| V <sub>DD</sub> Input voltage, V48  | 44  | 48  | 57  | V    |
| T <sub>J</sub> Junction temperature | –40 |     | 125 | °C   |

### 7.4 Thermal Information

| THERMAL METRIC <sup>(1)</sup> |                                              | PAP [HTQFP] | PJD [HTQFP]         | UNIT |
|-------------------------------|----------------------------------------------|-------------|---------------------|------|
|                               |                                              | 64 PINS     | 64 PINS             |      |
| R <sub>θJA</sub>              | Junction-to-ambient thermal resistance       | 23.9        | 30.1 <sup>(2)</sup> | °C/W |
| R <sub>θJC(top)</sub>         | Junction-to-case (top) thermal resistance    | 8.4         | 0.3                 |      |
| R <sub>θJB</sub>              | Junction-to-board thermal resistance         | 6.9         | 7.4                 |      |
| Ψ <sub>JT</sub>               | Junction-to-top characterization parameter   | 0.2         | 0.2                 |      |
| Ψ <sub>JB</sub>               | Junction-to-board characterization parameter | 6.8         | 7.4                 |      |
| R <sub>θJC(bot)</sub>         | Junction-to-case (bottom) thermal resistance | 0.2         | N/A                 |      |

- (1) For more information about traditional and new thermal metrics, see the *IC Package Thermal Metrics* application report, [SPRA953](#).
- (2) R<sub>θJA</sub> will vary with the heat sink used. Data modeled using 15 mm x 15 mm x 5 mm copper block heat sink.

### 7.5 Electrical Characteristics

V48 = 48 V, R<sub>T</sub> = 124 kΩ, C<sub>T</sub> = 220 pF, C<sub>INT</sub> = 0.027 μF (low leakage), –40°C to 125°C and T<sub>A</sub> = T<sub>J</sub> (unless otherwise noted)

| PARAMETER                                  | TEST CONDITIONS               | MIN  | TYP  | MAX  | UNIT |
|--------------------------------------------|-------------------------------|------|------|------|------|
| <b>Power Supply</b>                        |                               |      |      |      |      |
| V48 quiescent current                      | Off mode (all ports)          | 4    | 9    | 12   | mA   |
| V48 quiescent current                      | Powered mode (all ports)      |      | 10   | 14   |      |
| V <sub>I0</sub> , internal analog supply   | I <sub>LOAD</sub> = 0         | 9.75 | 10.5 | 11.5 | V    |
| V <sub>3.3</sub> , internal digital supply | I <sub>LOAD</sub> = 0 to 3 mA | 3    | 3.3  | 3.7  |      |
| V <sub>3.3</sub> short circuit current     | V = 0                         | 3    |      | 12   | mA   |

## Electrical Characteristics (continued)

V48 = 48 V,  $R_T = 124\text{ k}\Omega$ ,  $C_T = 220\text{ pF}$ ,  $C_{INT} = 0.027\text{ }\mu\text{F}$  (low leakage),  $-40^\circ\text{C}$  to  $125^\circ\text{C}$  and  $T_A = T_J$  (unless otherwise noted)

| PARAMETER                                         | TEST CONDITIONS                                                                 | MIN                 | TYP   | MAX  | UNIT         |
|---------------------------------------------------|---------------------------------------------------------------------------------|---------------------|-------|------|--------------|
| V6.3, internal supply                             | I <sub>LOAD</sub> = 0                                                           | 5                   | 6.3   | 7    | V            |
| V2.5, internal reference supply                   | I <sub>LOAD</sub> = 0                                                           | 2.46                | 2.5   | 2.54 |              |
| Input UVLO                                        |                                                                                 |                     | 26    | 32   |              |
| Internal POR time out(I <sup>2</sup> C)           | After all supplies are good I <sup>2</sup> C activity is valid                  |                     | 8     |      | Clock Pulses |
| Internal POR time out (Port)                      | After all supplies are good Port active to I <sup>2</sup> C commands            |                     | 66000 |      |              |
| Port Discovery                                    |                                                                                 |                     |       |      |              |
| Port off #P to #N input resistance                |                                                                                 | 400                 | 600   |      | kΩ           |
| Discovery open circuit voltage                    |                                                                                 |                     | 22    | 30   | V            |
| Discovery 1 voltage loop control                  | 70 μA < I <sub>PORT</sub> < 3 mA                                                | 2.8                 | 4.4   |      |              |
| Discovery 2 voltage loop control                  | 70 μA < I <sub>PORT</sub> < 3 mA                                                |                     | 8.8   | 10   |              |
| Discovery current limit                           | P = N = 48 V                                                                    | 3                   | 4     | 5    | mA           |
| Auto-mode discovery resistance acceptance Band    |                                                                                 | 19                  |       | 26.5 | kΩ           |
| Auto-mode discovery resistance low end rejection  |                                                                                 | 0                   |       | 15   |              |
| Auto-mode discovery resistance high end rejection |                                                                                 | 33                  |       |      |              |
| Discovery1,2 A/D conversion scale factor          | 100 μA < I <sub>PORT</sub> < 3 mA                                               | 5.30                | 6.10  | 6.75 | count/μA     |
| Port Classification                               |                                                                                 |                     |       |      |              |
| Classification voltage loop controll              | 100 μA < I <sub>PORT</sub> < 50 mA                                              | 15                  | 17.5  | 20   | V            |
| Classification current limit                      | P = N = 48 V                                                                    | 50                  | 60    | 100  | mA           |
| Class 0 to 1 detection threshold                  |                                                                                 | 5.5                 | 6.5   | 7.5  |              |
| Class 1 to 2 detection threshold                  |                                                                                 | 13                  | 14.5  | 16   |              |
| Class 2 to 3 detection threshold                  |                                                                                 | 21                  | 23    | 25   |              |
| Class 3 to 4 detection threshold                  |                                                                                 | 31                  | 33    | 35   |              |
| Class 4 to 0 detection threshold                  |                                                                                 | 45                  | 48    | 51   |              |
| Classification A/D conversion scale factor        |                                                                                 | 375                 | 424   | 475  | Count/<br>mA |
| Port Legacy Detection                             |                                                                                 |                     |       |      |              |
| Legacy current limit                              | P = N = 48 V                                                                    | 2.6                 | 3.5   | 4.3  | mA           |
| Legacy voltage A/D conversion scale factor        | 100 mV < V <sub>PORT</sub> < 17.5 V                                             | 1365                | 1400  | 1445 | Count/V      |
| Port Powered Mode                                 |                                                                                 |                     |       |      |              |
| Port on resistance                                | 20 mA < I <sub>PORT</sub> < 300 mA                                              |                     | 1.3   | 1.8  | Ω            |
| Over current threshold (I <sub>CUT</sub> )        | R <sub>BIAS</sub> = 124 kΩ, C <sub>T</sub> = 220 pF, −25 ≤ T <sub>J</sub> ≤ 105 | 350                 | 375   | 400  | mA           |
| Output current limit (I <sub>LIM</sub> )          |                                                                                 |                     | 425   | 450  |              |
| Disconnect timer current threshold                | R <sub>BIAS</sub> = 124 kΩ, C <sub>T</sub> = 220 pF                             |                     | 7.5   | 10   |              |
| Port output UV                                    |                                                                                 | 42.0                | 42.7  | 44.0 | V            |
| Port output OV                                    |                                                                                 | 54                  | 55    | 56   |              |
| Port current A/D conversion scale factor          | 20 mA < I <sub>PORT</sub> < 56 V                                                | 31                  | 36.41 | 40   | Count/<br>mA |
| Port voltage A/D conversion scale factor          | 45 V < V <sub>PORT</sub> < 56 V                                                 | 335                 | 353   | 370  | Count/V      |
| Port temperature A/D conversion                   |                                                                                 | (17500 - counts)/16 |       |      | °C           |
| Port Disable Mode                                 |                                                                                 |                     |       |      |              |
| Port N voltage                                    | P = 48 V                                                                        | 47                  |       |      | V            |

## Electrical Characteristics (continued)

V<sub>48</sub> = 48 V, R<sub>T</sub> = 124 kΩ, C<sub>T</sub> = 220 pF, C<sub>INT</sub> = 0.027 μF (low leakage), –40°C to 125°C and T<sub>A</sub> = T<sub>J</sub> (unless otherwise noted)

| PARAMETER                                                | TEST CONDITIONS           | MIN  | TYP | MAX  | UNIT |
|----------------------------------------------------------|---------------------------|------|-----|------|------|
| AC LO and AC HI Specification                            |                           |      |     |      |      |
| AC_LO, AC_HI – low output voltage                        |                           | 0    |     | 0.5  | V    |
| AC_LO – high output voltage                              |                           | 3.0  |     | 5.0  |      |
| AC_HI – high output voltage                              |                           | 5.0  |     | 7.0  |      |
| Digital I <sup>2</sup> C DC Specifications               |                           |      |     |      |      |
| SCL logic low input threshold (V <sub>IL</sub> )         |                           | 0.5  |     |      | V    |
| SDA_I logic low input threshold (V <sub>IL</sub> )       |                           | 1.25 |     |      | V    |
| SCL, SDA_I logic high input threshlod (V <sub>IH</sub> ) |                           |      |     | 1.75 | V    |
| A1–A5 ,WD_DIS, ALTA/B, MS, PORB logic input threshold    |                           | 1.5  |     |      | V    |
| MS, PORB input hysteresis                                |                           | 150  |     |      | V    |
| WD_DIS,ALTA/B, MS, PORB input pulldown resistance        | Input voltage 0.5 to 3 V  | 50   |     |      | kΩ   |
| A1–A5 pull-down current                                  |                           | 10   |     |      | μA   |
| SDA_O logic high leakage                                 | Drain = 5 V               | 100  |     |      | nA   |
| SDA_O logic low                                          | I <sub>SINK</sub> = 10 mA | 200  |     |      | mV   |
| INTB logic high leakage                                  | Drain = 6 V               | 10   |     |      | μA   |
| INTB logic low                                           | I <sub>SINK</sub> = 10 mA | 200  |     |      | mV   |

## 7.6 Timing Requirements

|                                                         |                                                                                            | MIN   | NOM | MAX   | UNIT |
|---------------------------------------------------------|--------------------------------------------------------------------------------------------|-------|-----|-------|------|
| <b>Port Discovery</b>                                   |                                                                                            |       |     |       |      |
| Discovery1,2 A/D conversion time                        | I <sub>PORT</sub> = 120 μA                                                                 |       | 18  | 22    | ms   |
| <b>Port Classification</b>                              |                                                                                            |       |     |       |      |
| Classification A/D conversion time                      | I <sub>PORT</sub> = 50 mA                                                                  |       | 18  | 22    | ms   |
| <b>Port Legacy Detection</b>                            |                                                                                            |       |     |       |      |
| Legacy A/D conversion time                              | 0 V < V <sub>PORT</sub> < 15 V                                                             |       | 18  | 22    | ms   |
| <b>Port Powered Mode</b>                                |                                                                                            |       |     |       |      |
| t <sub>MPDO</sub> , disconnect detection time           | R <sub>BIAS</sub> = 124 kΩ, C <sub>T</sub> = 220 pF, I <sub>LOAD</sub> < current threshold | 300   |     | 400   | ms   |
| Over current time out (T <sub>OVL</sub> )               | R <sub>BIAS</sub> = 124 kΩ, C <sub>T</sub> = 220 pF                                        | 50    |     | 75    | ms   |
| Short circuit time out (T <sub>LIM</sub> )              | R <sub>BIAS</sub> = 124 kΩ, C <sub>T</sub> = 220 pF                                        | 50    |     | 75    |      |
| Turn-off delay from UV/OV faults                        | R <sub>BIAS</sub> = 124 kΩ, C <sub>T</sub> = 220 pF, After port enabled and ramped up      |       | 3   |       |      |
| Port current A/D conversion time                        | I <sub>PORT</sub> < 300 mA                                                                 |       | 18  | 22    | ms   |
| Port voltage A/D conversion time                        | 45 V < V <sub>PORT</sub> < 56 V                                                            |       | 18  | 22    | ms   |
| <b>Digital I<sup>2</sup>C Timing</b>                    |                                                                                            |       |     |       |      |
| SCL clock frequency, f <sub>SCL</sub>                   |                                                                                            | 0     |     | 400   | kHz  |
| Pulse duration, t <sub>HIGH</sub>                       | SCL high                                                                                   | 0.6   |     |       | μs   |
| Pulse duration, t <sub>LOW</sub>                        | SCL low                                                                                    | 1.3   |     |       |      |
| Rise time, SCL and SDA, t <sub>r</sub>                  |                                                                                            |       |     | 0.300 |      |
| Fall time, SCL and SDA, t <sub>f</sub>                  |                                                                                            |       |     | 0.300 |      |
| Setup time, SDA to SCL, t <sub>SU;DAT</sub>             |                                                                                            | 0.250 |     |       |      |
| Hold time, SCL to SDA, t <sub>HD;DAT</sub>              |                                                                                            | 0.300 |     | 0.900 |      |
| Bus free time between start and stop, t <sub>BUF</sub>  |                                                                                            | 1.3   |     |       |      |
| Setup time, SCL to start condition, t <sub>SU;STA</sub> |                                                                                            | 0.6   |     |       |      |
| Hold time, start condition to SCL, t <sub>HD;STA</sub>  |                                                                                            | 0.6   |     |       |      |
| Setup time, SCL to stop condition, t <sub>SU;STO</sub>  |                                                                                            | 0.6   |     |       |      |

## 7.7 Typical Characteristics

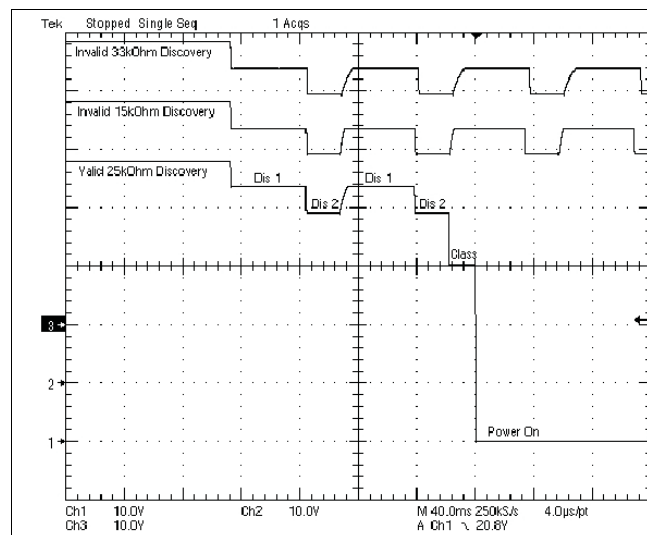


Figure 1. Invalid (33 kΩ and 15 kΩ) and Valid Discovery (25 kΩ)

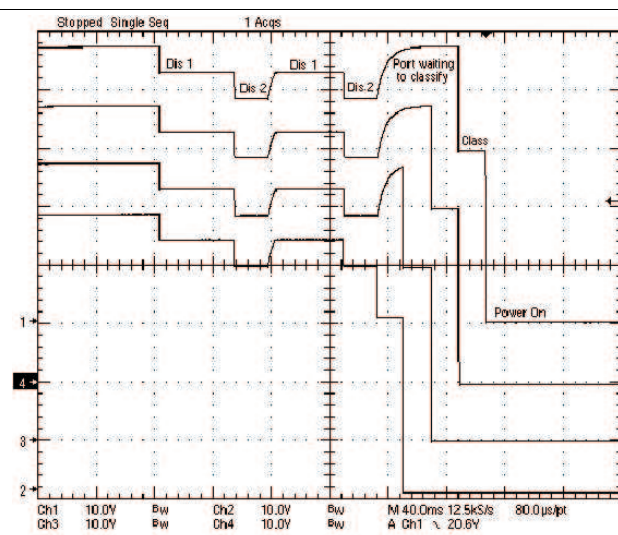


Figure 2. Four Port Discovery, Class, Power On

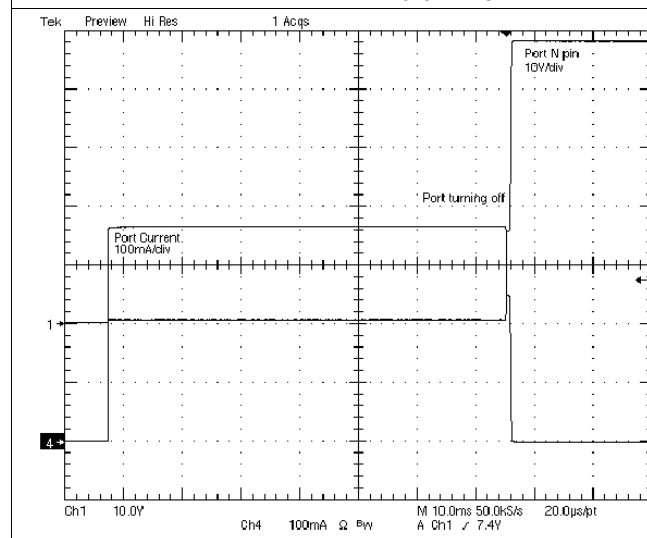


Figure 3. Port Over-current Response

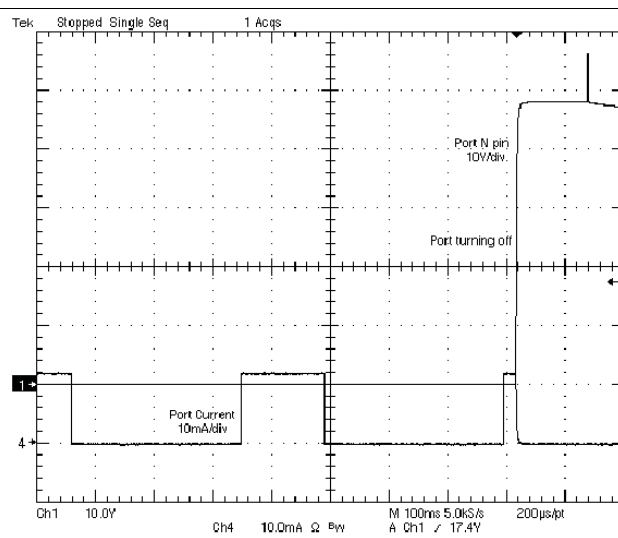
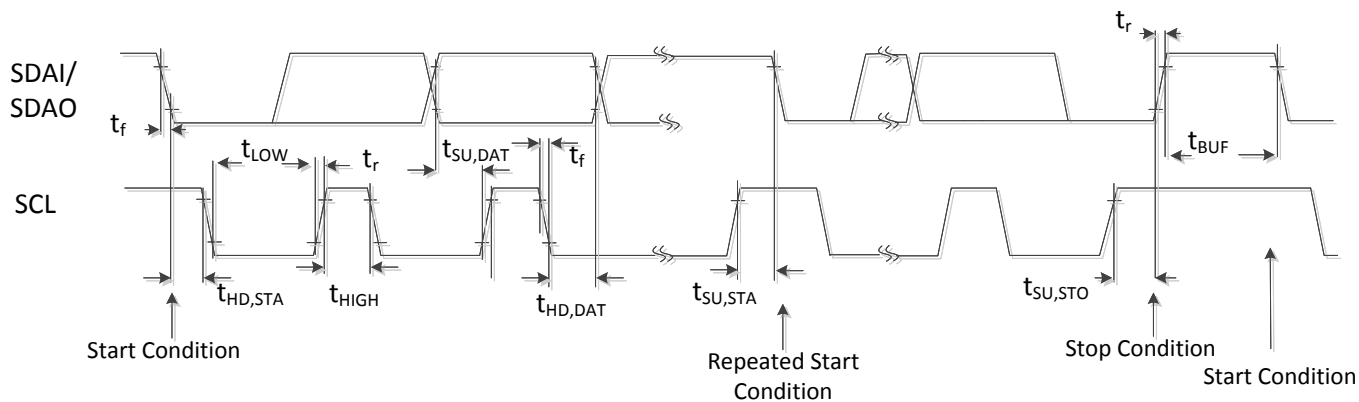


Figure 4. Port Under-current Response in DC Disconnect

## 8 Parameter Measurement Information



## 9 Detailed Description

### 9.1 Overview

The TPS2384 has three internal supply buses (10 V, 6.3 V and 3.3 V) generated from the 48-V input supply. These supplies are used to bias all internal digital and analog circuitry. Each supply has been brought out separately for proper bypassing to insure high performance. The digital supply (3.3 V) is available for powering external loads up to 2 mA. For more demanding loads it is highly recommended to use external buffers to prevent system degradation. When the TPS2384 is initially powered up an internal Power-on-Reset (POR) circuit resets all registers and sets all ports to the off state to ensure that the device is powered up in a known safe operating state.

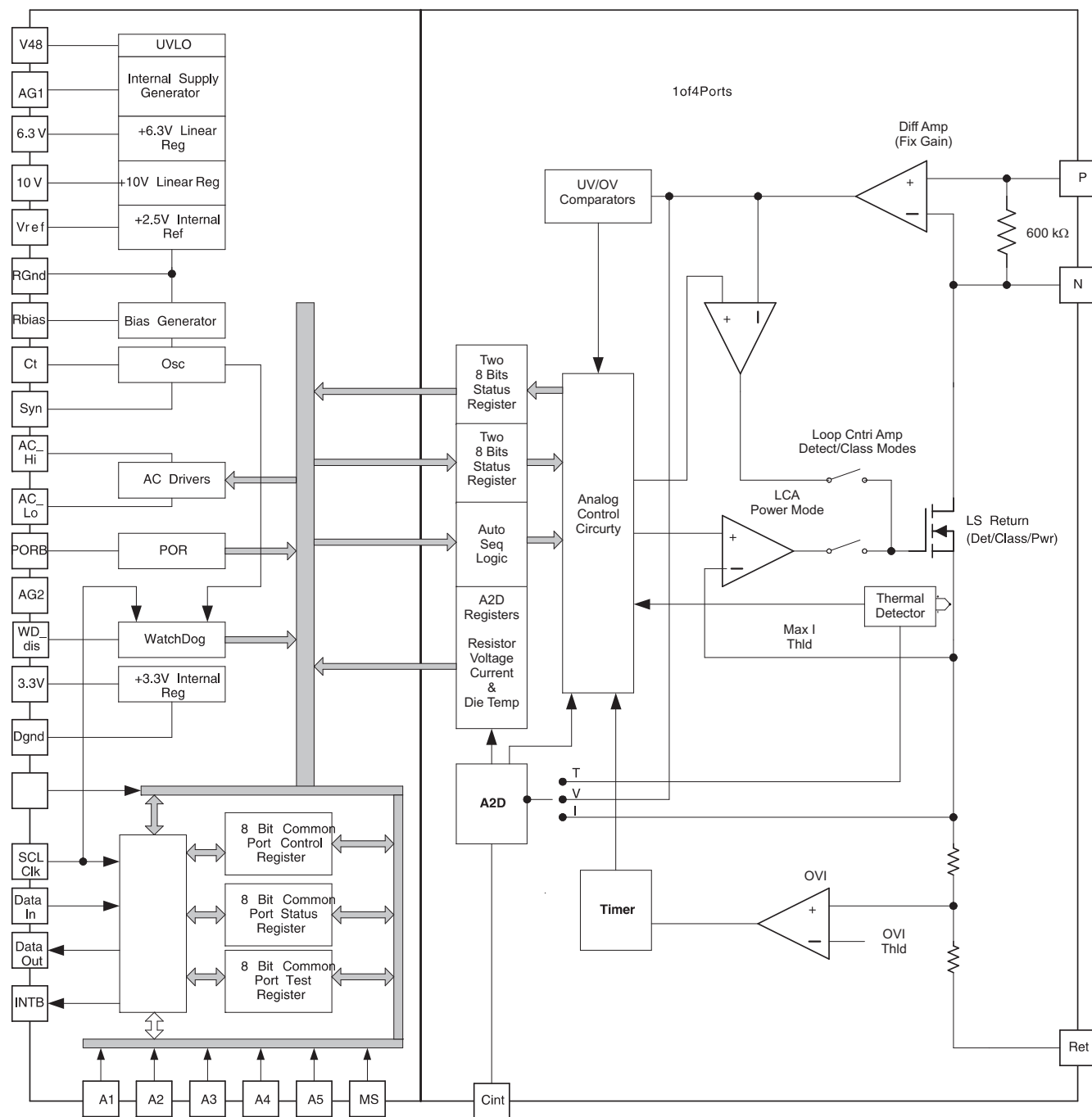
The TPS2384 has three modes of operation; automode (AM), semi-automode (SAM) and power management mode (PMM).

- In auto mode the TPS2384 performs discovery, classification and delivery of power autonomously to a compliant PD without the need of a micro-controller.
- In semi-automode the TPS2384 operates in automode but users can access the contents of all read status registers and A/D registers through the I<sup>2</sup>C serial interface. All write control registers are active except for D0 through D3 of Port Control register 1 (Address 0010) for limited port control. The semi-auto mode allows the TPS2384 to detect valid PD's without micro-controller intervention but adds a flexibility to perform power management activities.
- Power management mode (with a micro-controller) allows users additional capabilities of discovering non-compliant (legacy) PDs, performing AC Disconnect and advanced power management system control that are based on real time port voltages and currents. All functions in this mode are programmed and controlled through read/write registers over the I<sup>2</sup>C interface. This allows users complete freedom in detecting and powering devices. A comprehensive software package is available that mates the power of the TPS2384 with the MSP430 micro-controller.

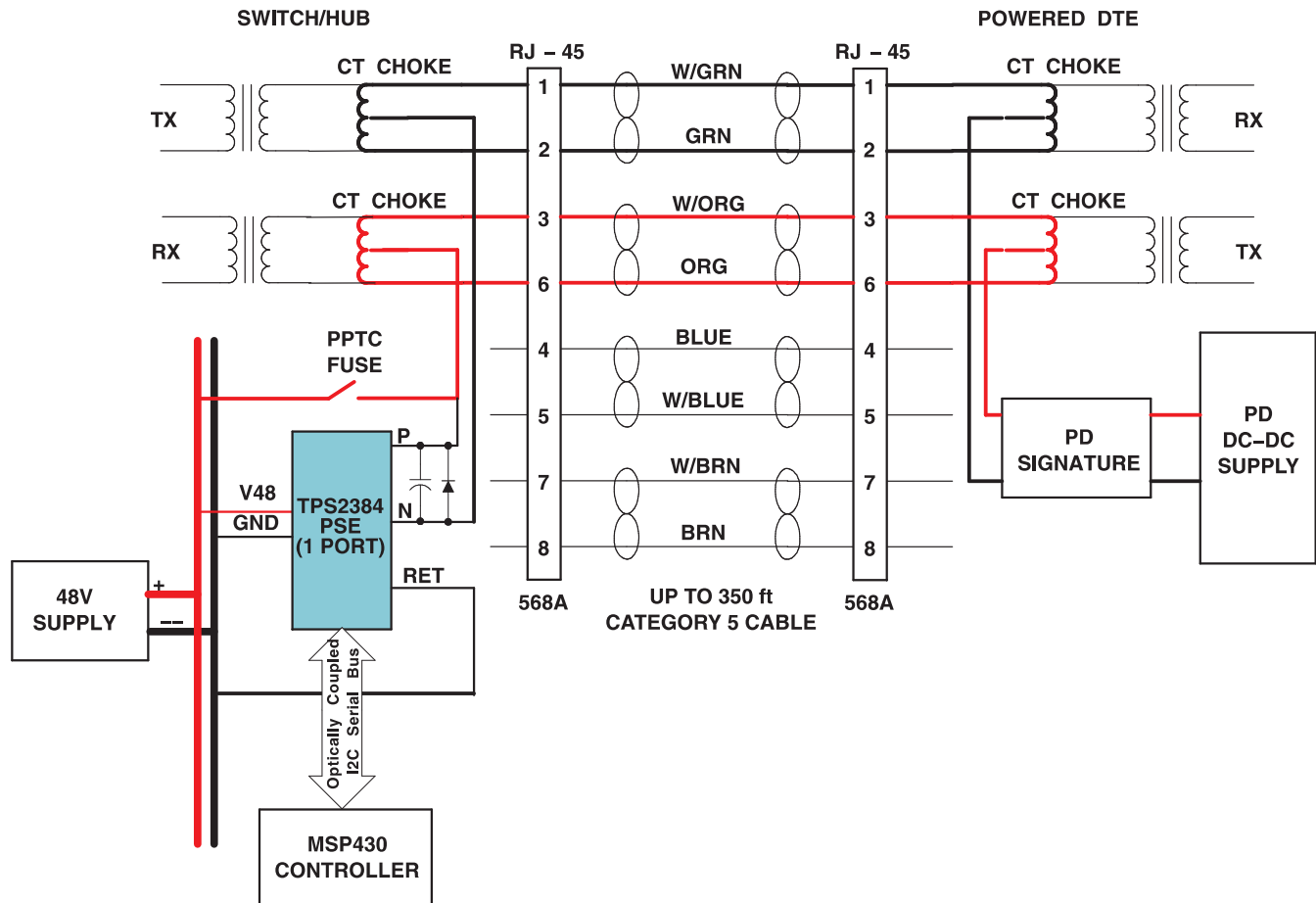
TPS2384 integrated output stage provides port power and low-side control. The internal low-side circuitry is designed with internal current sensing so there are no external resistors required. The output design ensures the power switches operate in the fully enhanced mode for low power dissipation.

The I<sup>2</sup>C interface allows easy application of opto-coupler circuitry to maintain Ethernet port isolation when a ground based micro-controller is required. The TPS2384 five address pins (A1–A5) allow the device to be addressed at one of 31 possible I<sup>2</sup>C addresses. Per-port write registers separately control each port state (discovery, classification, legacy, power up, etc) while the read registers contain status information of the entire process along with parametric values of discovery, classification, and real-time port operating current, voltage and die temperature.

The proprietary 15-bit integrating A/D converter is designed to meet the harsh environment where the PSEPM resides. The converter is set for maximum rejection of power line noise allowing it to make accurate measurements of line currents during discovery, classification and power delivery for reliable power management decisions.



## Functional Block Diagrams (continued)



NOTE: A fuse may be required to provide additional protection if isolation is lost or the low-side current sense fails.

**Figure 6. System Block Diagram**

## 9.3 Feature Description

### 9.3.1 PMM Faults

PMM faults are the same as those shown in the [AM Faults and INTB Output](#) section. In PM mode, the port under- and overvoltage and under-current faults can be disabled by writing to the control bits in the appropriate register. Monitoring for these fault conditions is enabled by default after device POR or other reset operation. The enable state of these features can be toggled by writing to the corresponding control bit as defined below and in [Table 4](#) and [Table 5](#).

The PMM faults are:

- Port under- and over-voltage faults (disable via Common Control register 0001b, bit D2)
- Overcurrent fault (cannot be disabled)
- Under-current (DC Disconnect) fault (disable via Port Control register 0010b, bit D4)
- Thermal shutdown (TSD) fault (cannot be disabled)
- Watchdog fault (disable via WD\_DIS pin)

Any one of these faults causes the port to shutdown. Once a fault has occurred the port can not be repowered until a Disable function is sent. The Disable function clears the fault latch and the fault register.

INTB pin operation is essentially the same in PMM as in AM, with the following exceptions:

## Feature Description (continued)

- For load under-current to generate a fault shutdown and status indication, the condition of load current less than the threshold must be detected by the continuous sample (C\_SAMPLE) function (0111b).
- In PMM only, a Watchdog timer fault also asserts INTB.

### 9.3.2 Watchdog Timer

TPS2384 has two watchdog timers. One monitors the I<sup>2</sup>C clock and the other monitors the internal clock. When automode is selected and the watchdog timer has not been disabled only the internal clock is monitored. When in power management mode and the watchdog timer has not been disabled then both the I<sup>2</sup>C and internal clocks are monitored. If there is no I<sup>2</sup>C clock activity for approximately two seconds then all ports are disabled. There are three means to enable ports after a I<sup>2</sup>C clock fault and they are:

1. Hard power reset
2. PORB pulse
3. Writing a software reset to the Common Control register

In both auto mode and power management mode if the internal oscillator is lost for more than 20 ms all ports are disabled.

Loss of these signals is considered catastrophic since the system loses its ability to talk to each port. Therefore the watchdog timers disabling all ports protects the system.

This function can be easily over ridden by setting the WD\_DIS pin high.

## 9.4 Device Functional Modes

### 9.4.1 Auto Mode

Auto mode (AM, MS = 0) operation is the basic approach for applying power to IEEE compliant PD's. When AM has been selected the TPS2384 automatically performs the following functions:

- Discovery of IEEE 802.3af compliant powered devices (PD's)
- Classification
- Power delivery
- Port over/under voltage detection
- Port over current detection ( $350\text{ mA} < I_{\text{PORT}} < 400\text{ mA}$ )
- Port maximum current limit ( $400\text{ mA} < I_{\text{PORT}} < 450\text{ mA}$ )
- DC Disconnect ( $5\text{ mA} < I_{\text{PORT}} < 10\text{ mA}$ )
- Thermal shutdown protection (TSD), ( $T_J > 150^\circ\text{C}$ )
- Internal oscillator watchdog

In AM the contents of all read registers are available via the I<sup>2</sup>C interface. In addition all control registers except for the function bits can be written. This supports a semi-automode where the TPS2384 auto detects compliant PD's while a host can access the A/D registers and class information and then implement power management (including turning a port off, responding to faults, etc).

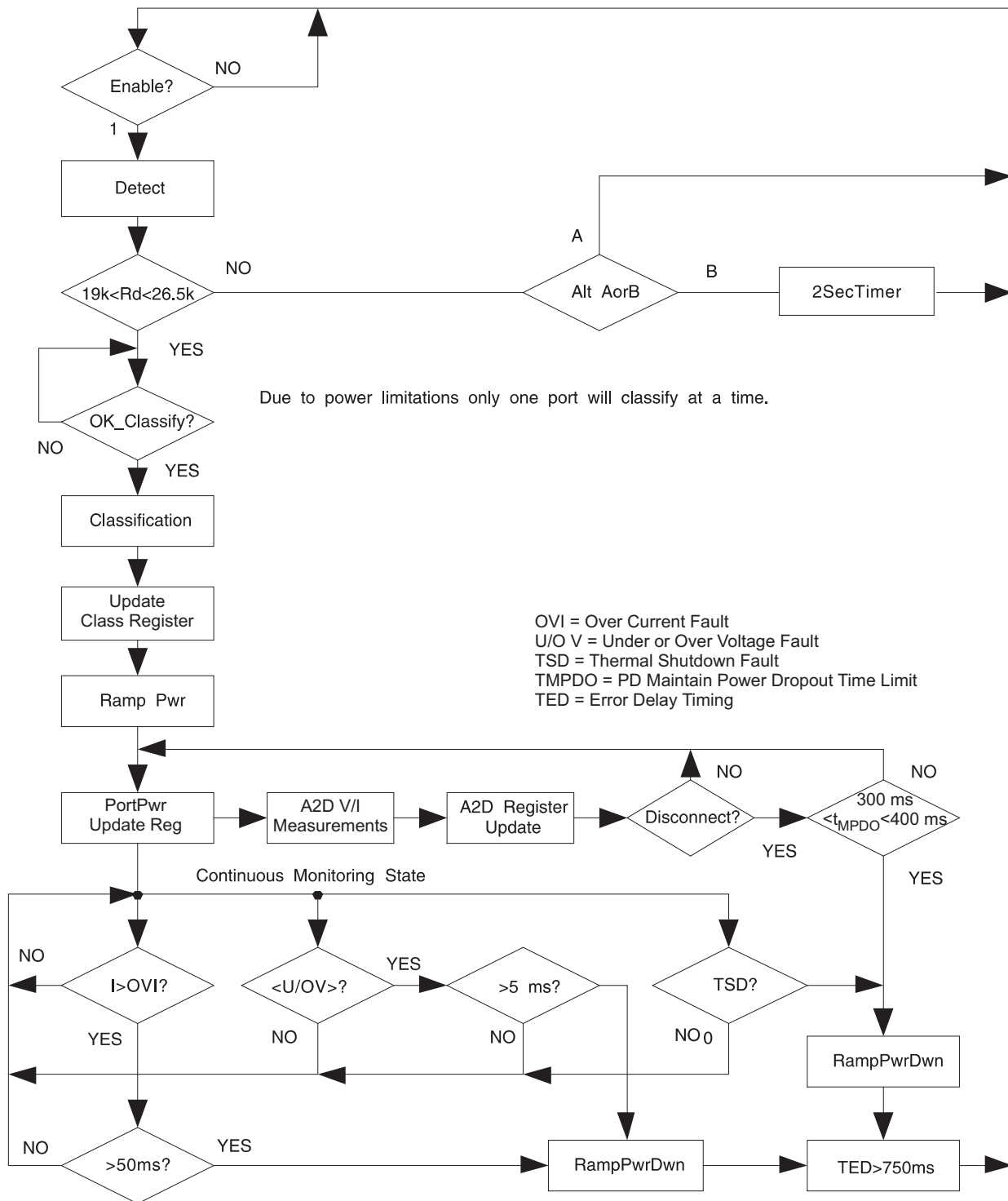
The write registers that are still active in AM are:

- All ports disable – Common Control register 0001b
- Over/Under Voltage Faults – Common Control register 0001b
- Software reset – Common Control register 0001b
- Disconnect disable – Port Control 1 register 0010b
- Discovery fault disable – Port Control 1 register 0010b
- Port enable – Port Control 2 register 0011b

For Alternative B, semi-auto mode implementations which will manipulate the all Ports Disable or Port Enable bits, refer to ([SLUZ014](#)).

## Device Functional Modes (continued)

### 9.4.2 Auto Mode Functional Description

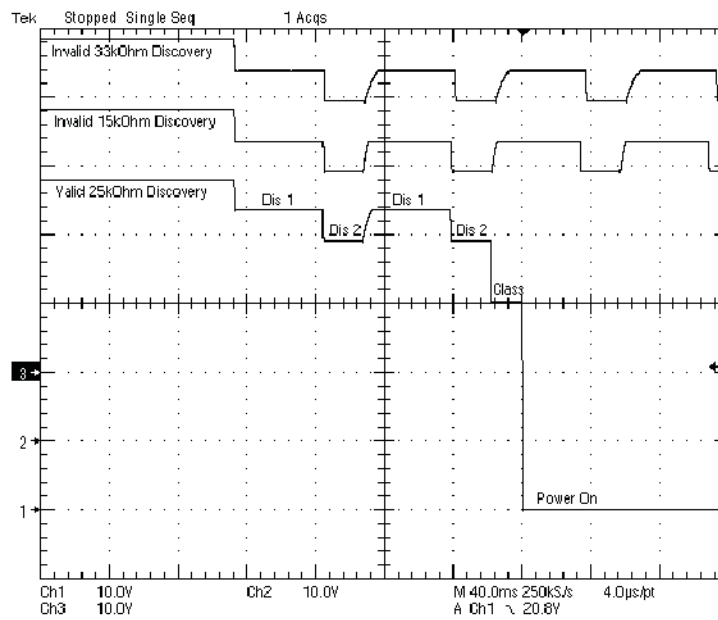


**Figure 7. The Basic Flow for Auto Mode**

## Device Functional Modes (continued)

### 9.4.2.1 AM Discovery

The TPS2384 uses a four-point measurement technique using two low level probe signals (typically 4.4 V and 8.8 V) during the discovery process to determine whether a valid PD is present. The use of a multipoint detection method for the PD resistor measurement allows accurate detection even when series steering diodes are present. The low level probe voltages also prevent damage to non-802.3 devices. When a valid PD has been detected the TPS2384 moves to classification. If a valid PD has not been detected the TPS2384 continues to cycle through the discovery process. The waveform in Figure 8 shows typical N-pin waveforms for the discovery of a valid PD and the failure to discovery due to a discovery resistor of 15 kΩ and 33 kΩ.

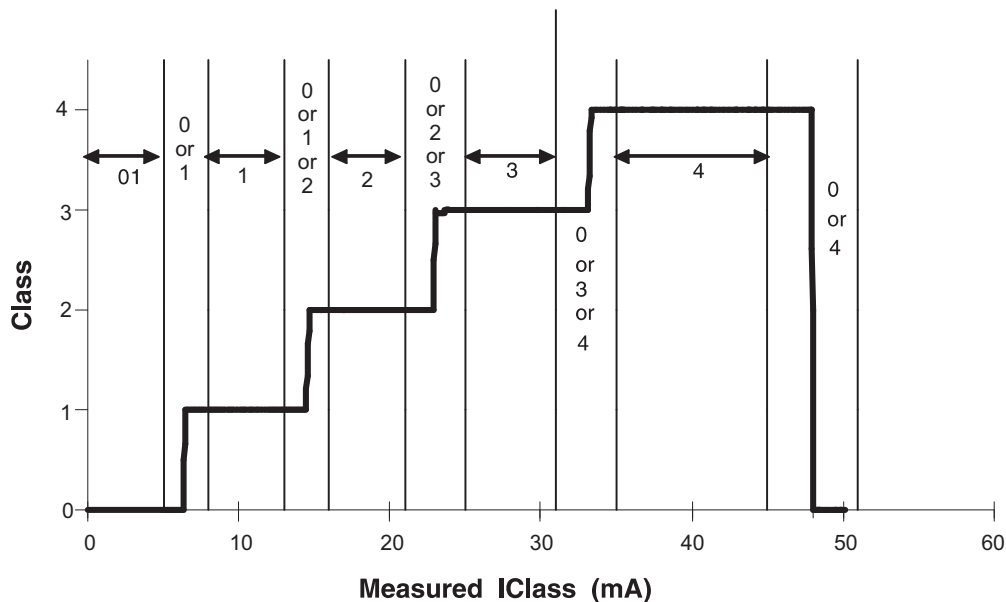


**Figure 8. Invalid (33 kΩ and 15 kΩ) and Valid Discovery (25 kΩ)**



## Device Functional Modes (continued)

Upon completion of classification the port classification register is updated. In AM mode this information is not used but for semi-auto mode the class information can be used for power management. [Figure 10](#) shows actual class currents and the class assignment which were stored in the register. These assignments are compliant with the IEEE 802.3af Standard

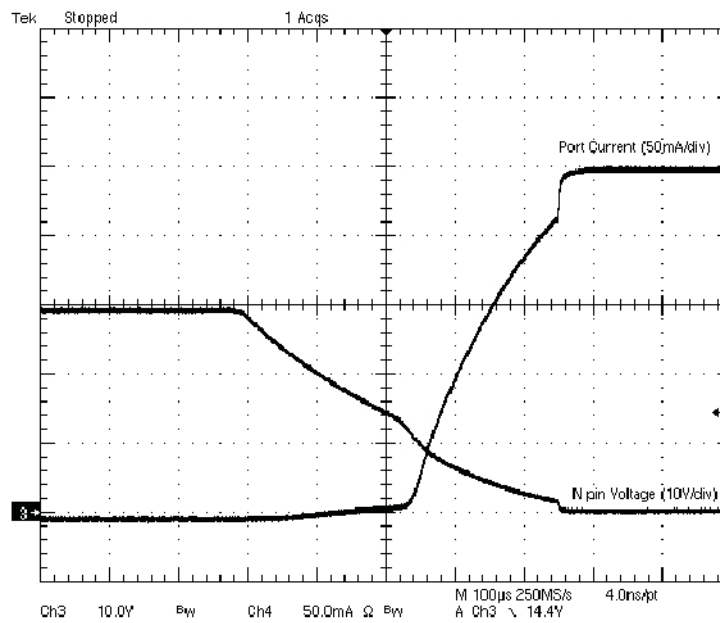


**Figure 10. Class Current and Class Assignments**

## Device Functional Modes (continued)

### 9.4.2.3 AM Power Delivery

After successfully discovery and classification of a valid PD the power is delivered by controlling the current to the PD until its current requirements are met or until the internal current limit is reached (approximately 425 mA). The power switch is fully enhanced after 500  $\mu$ s. [Figure 11](#) show the voltage and the current that is being applied to the PD during power-up and reaching the PD load of 250 mA.



**Figure 11. Port Power Delivery Voltage and Current**

After power has been applied to the PD the TPS2384 automatically enters the current and voltage sample mode. The sample mode performs 31 current measurements and 1 voltage measurement. Each measurement takes approximately 18 ms to complete. The port remains powered and the current/voltage measurement cycle continues until a fault condition occurs. The current and voltage measurements are both stored in the A/D current and voltage registers and can be accessed through the I<sup>2</sup>C pins. This allows power management in the AM if it is desired.

### 9.4.3 AM Faults and INTB Output

AM faults are:

- Port under and over voltage faults
- Over current faults
- Under current (DC Disconnect) fault
- Thermal shutdown (TSD) fault
- Watchdog timer faults (disabled via WD\_DIS pin)

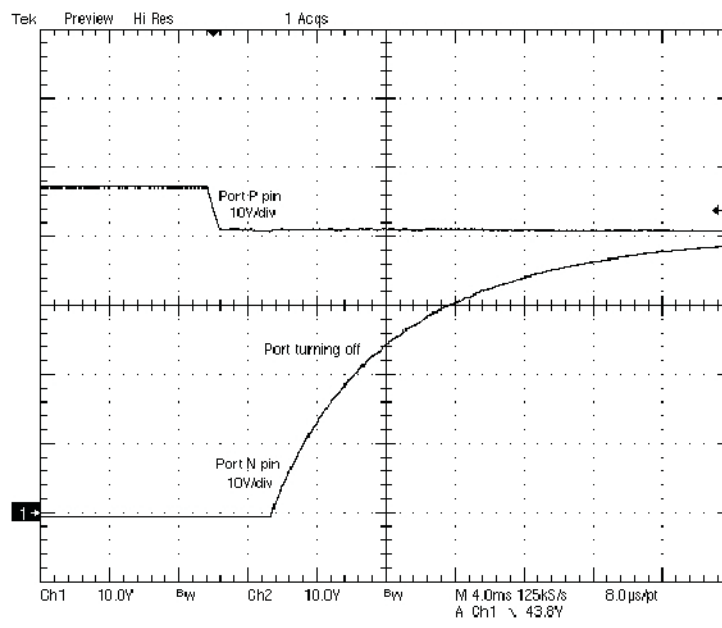
Any one of the first four fault conditions listed above causes the port to shut down, and a 3-bit fault code to be latched into the affected port's Status Read 1 register (addr = 0100b). Watchdog faults cause all four ports to shut down. Faulted ports are temporarily disabled after a fault has been detected and latched.

The INTB pin is an open-drain, active-low output which is asserted if a fault condition occurs on any of the four ports. This indication is asserted for any of the port faults which result in a code displayed in the port status register (the faults listed in [Table 8](#)). In automode, the fault latch, the status register fault bits, and consequently, INTB assertion, are cleared by expiration of the 750-ms TED timer.

### Device Functional Modes (continued)

#### 9.4.4 Over/Under Voltage Fault

Over/under voltage faults are only processed after port powerup has completed (voltage/power ramp to PD is done). The TPS2384 measures the voltage between the P and N pin and if this voltage drops below the under voltage threshold (typically 43 V) or increases above the over voltage threshold (typically 55 V) the voltage timer is turned on. When the voltage timer reaches its time-out limit that is set between 2 ms to 5 ms the corresponding port is turned off and the UV/OV fault code generated in the Port Status 1 register. If the over/under voltage condition is removed prior to the voltage timer reaching its limit the timer is reset and waits for the next event. [Figure 12](#) shows a voltage fault lasting for more then 2 ms that has caused the port to shutdown.

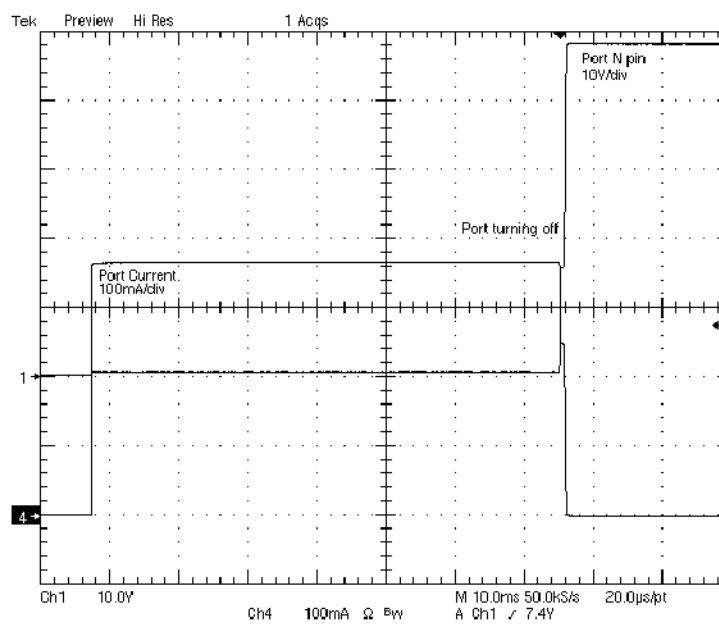


**Figure 12. Port Turn OFF due to Under Voltage Fault**

## Device Functional Modes (continued)

### 9.4.5 Over Current or Current Limit Faults

Over current or current limit faults are conditions when the load current that is being sensed trips either the  $I_{CUT}$  comparator (350 mA to 400 mA) or the  $I_{LIM}$  comparator (400 mA to 450 mA) and turns on the current fault timer. When the over current timer reaches its time out limit that is set between 50 ms to 75 ms the corresponding port is turned off and the over current fault code generated in the Port Status 1 register. If the over current condition goes away prior to the over current timer reaching its limit the timer is reset and waits for the next event. [Figure 13](#) shows an over current fault lasting more than 50 ms that has caused the port to shut off.



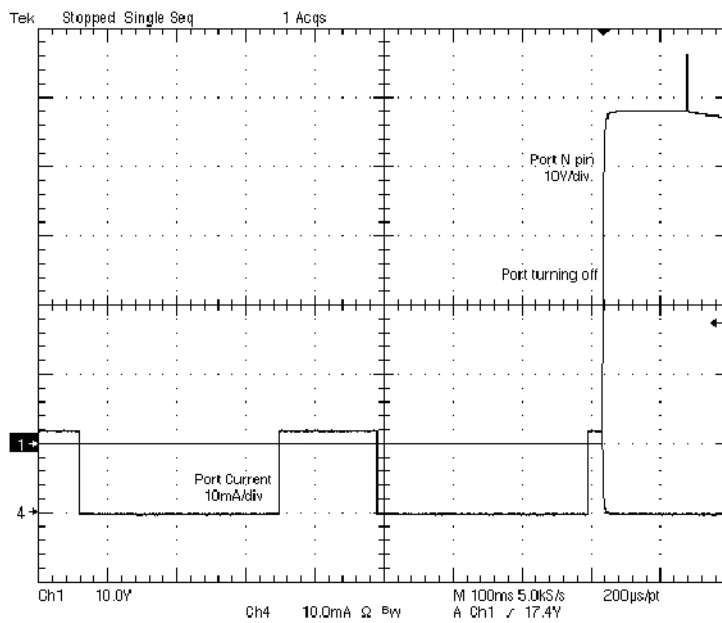
**Figure 13. Port Over-current Response**

## Device Functional Modes (continued)

### 9.4.6 Under Current Fault (DC Modulated Disconnect)

Under current fault (dc modulated disconnect) is a condition when the load current that is being measured drops below 7.5 mA and turns on the disconnect timer. If the disconnect timer reaches its time out limit that is set between 300 ms to 400 ms the corresponding port is turned off and the load disconnect fault code generated in the Port Status 1 register. If the under current condition goes away prior to the disconnect timer reaching its limit the timer is reset and the port remains powered.

Figure 14 shows DC Disconnect event. In this setup the load current was set right above the 7.5-mA threshold. The duty cycle of the load was then adjusted until the off period exceeded the disconnect time out, causing turn-off of the port. The time-out period was > 300 ms.



**Figure 14. Port Under-current Response in DC Disconnect**

## Device Functional Modes (continued)

### 9.4.7 Power Management Mode (PMM)

Power management mode (PMM) has been designed to work efficiently with simple low-cost microcontrollers such as those in the MSP430 family.

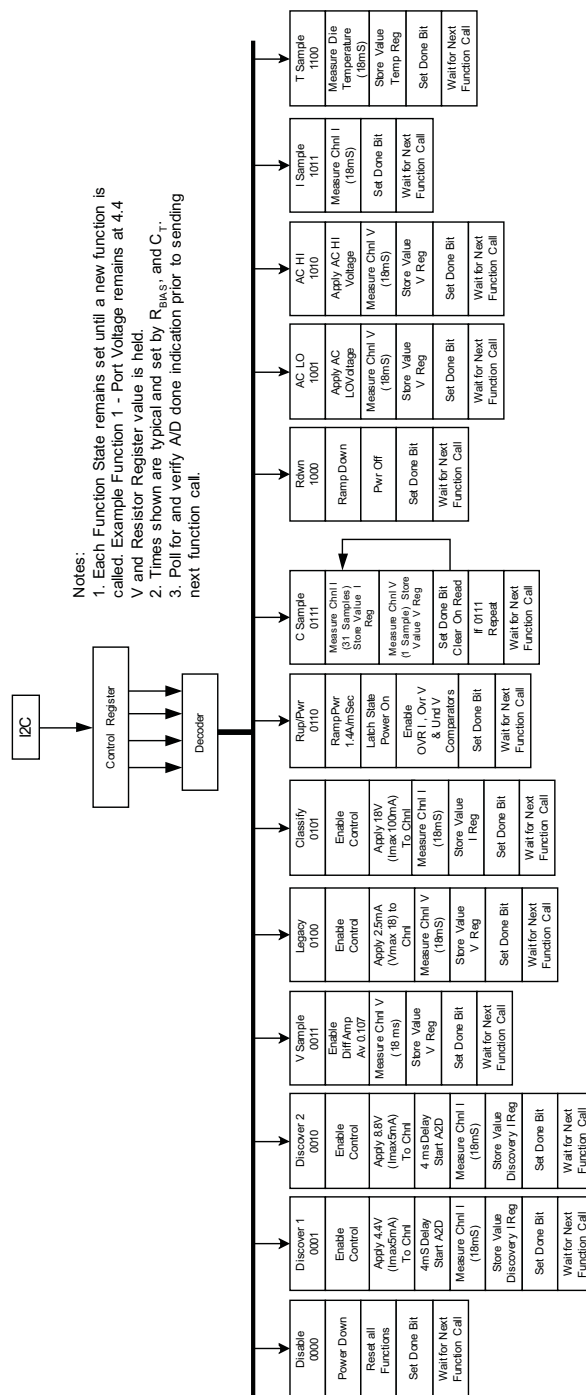
The power management mode uses 13 self-contained functions to completely control the device operation. Simply write/read through the I<sup>2</sup>C pins and wait for the function done bit to be set. If an A/D measurement was performed during the function the results can be accessed by going to the read mode and addressing the proper register. Refer to [Figure 15](#) for more detail.

#### 9.4.7.1 13 PMM Functions

- **Disable:** Disable the port and reset all functions.
- **Discovery 1:** Enable the Discovery 1 condition which applies a 4.4 V across the PD and measure and store the resulting current.
- **Discovery 2:** Enable the Discovery 2 condition which applies a 8.8 V across the PD and measure and store the resulting current.
- **V Sample:** Measure the voltage between the P and N pins and store the result in the A/D voltage register.
- **Legacy:** Enable the 3.5-mA current source for measuring capacitance and measure the voltage across the P and N terminals and store the result in the A/D voltage register.
- **Classify:** Enable the classification condition which applies 17.7 V across the PD and measure and store the resulting current.
- **Rup Pwr:** Turn on the output switch while controlling the current being delivered to the PD until the PD current needs are met or the max current is reached.
- **C Sample:** Continuous cycle of 31 current measurements and 1 voltage measurement. After each measurement the contents of the appropriate register are updated.
- **Rdwn:** Turn off the output switch while controlling current until output current reaches 0 mA.
- **AC LO:** Turns on low side output FET and measures voltage between P and N pin and store result in A/D voltage registers.
- **AC HI:** Turns on high side output FET and measures voltage between P and N pin and store result in A/D voltage registers.
- **ISample:** Measure the current and store the result in the A/D current register.
- **TSample:** Measure the internal die temperature and store the result in the A/D temperature register.

Conversion times for A/D measurements performed as part of the functions listed above are generally as shown in the typical values in the Electrical Characteristics table. However, conversion time is somewhat dependant on the magnitude of the input signal being measured. Power management mode applications should take precautions to test the A/D DONE bit (MSB of the high byte) of the pertinent results register before accepting or using the returned value. A logic 1 at this bit location indicates the conversion is complete. Also, once an A/D conversion is in process on a given port, subsequent function calls to that port should wait until the currently executing conversion is complete. Commands written prior to completion may cause the results of the initial conversion to be written to the register of the subsequent function.

## Device Functional Modes (continued)

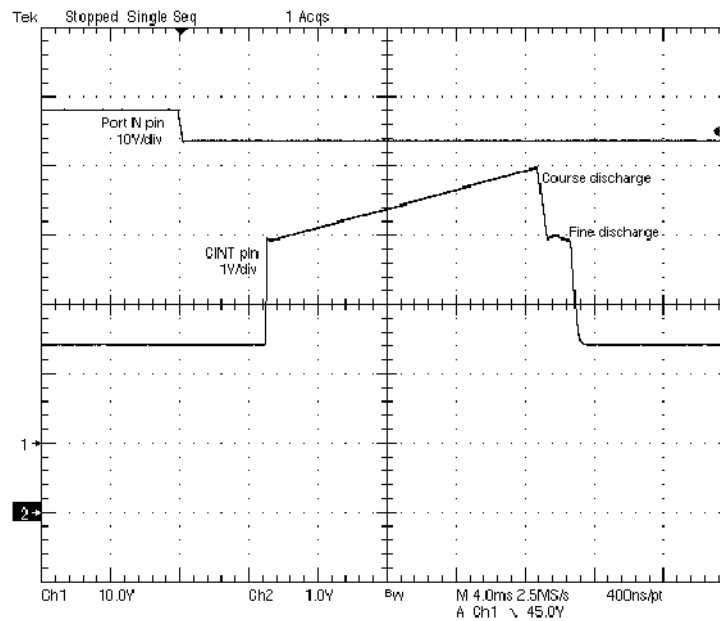


**Figure 15. Device Process Function Flow**

## Device Functional Modes (continued)

### 9.4.8 PMM Discovery 1

PMM Discovery 1 function waveforms for the N and CINT pins are shown in [Figure 16](#). The measurement is being performed using 25-k $\Omega$  impedance between the P and N pin. The Discovery 1 voltage is allowed to settle for approximately 5 ms before the A/D begins integrating. The voltage on the CINT pin shows the A/D cycle. There are four distinct regions to any A/D cycle: precharge (to a known starting voltage), charge, coarse discharge, and fine discharge. CINT pin is very high impedance therefore extreme care must be taken to avoid any noise or leakage affecting this pin. For the measurements where CINT voltage is shown a buffer was used to prevent performance degradation. The A/D measurement time is approximately 18 ms. The entire Discovery 1 function takes approximately 22 ms to complete. At the end of the A/D cycle the Discovery 1 current is stored in the Discovery Current Register and the function done bit is set. The applied Discovery 1 voltage level remains until another Discovery 1 or 2 function is called.

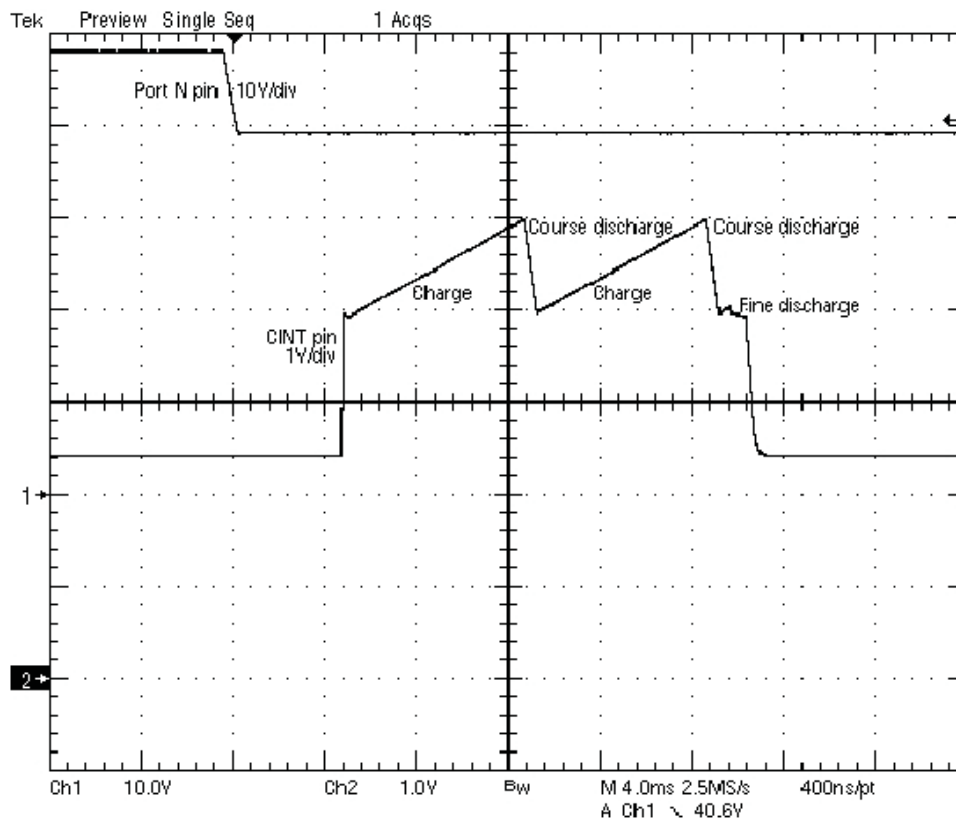


**Figure 16. Discovery 1 Function Waveforms**

## Device Functional Modes (continued)

### 9.4.9 PMM Discovery 2

PMM Discovery 2 function waveforms for the N and CINT pins are shown in Figure 17. Again the measurement is being performed using 25 k $\Omega$  impedance between the P and N pin. The Discovery 2 function was called after a Discovery 1 function so the voltage ramps from 4.4 V to 8.8 V below the P pin. The Discovery 2 voltage is given 5 ms to settle before the A/D begins to integrate. At the end of the A/D cycle the Discovery 2 current is stored in the Port Discovery Current Register and the function done bit is set. The applied Discovery 2 voltage level remains until a new function is called. The data for this measurement remains stored in the Discovery Current Register until another Discovery 1 or 2 function is called.



**Figure 17. Discovery 2 Function Waveforms**

## Device Functional Modes (continued)

### 9.4.10 PMM Classification

PMM Classification function looks similar to Discovery 1 and 2 except that the voltage between the P and N pins regulates to approximately 17.5 V. At the end of the A/D cycle the classification current is stored in the Port Current Register and the done bit is set. The applied classification level remains until a new function is called. The data for this measurement remains stored in the Port Current Register until either the Classify or ISample function is called.

As indicated in the flow diagram of [Figure 7](#), the TPS2384 in AM only performs classification at one port at a time. Similarly, PMM applications should take care to ensure that only one port per device is put into the classification mode at any one time to limit power dissipation in the package.

### 9.4.11 PMM Legacy

PMM Legacy function is used to detect PDs that are non compliant. Legacy detection uses a current source (typically 3.5 mA) as a test current while the A/D measures the average voltage for approximately 18 ms. The waveform shown in [Figure 18](#) is the Legacy function charging a 10-μF capacitor. The capacitance charges to a value that is no greater than 20 V below the P port voltage. As the capacitor is charging the A/D is accumulating counts in the voltage A/D register. [Figure 19](#) shows the relationship between port capacitance and the number of counts. A user can characterize non-compliant PD's signatures and use the Legacy function to recognize these devices.

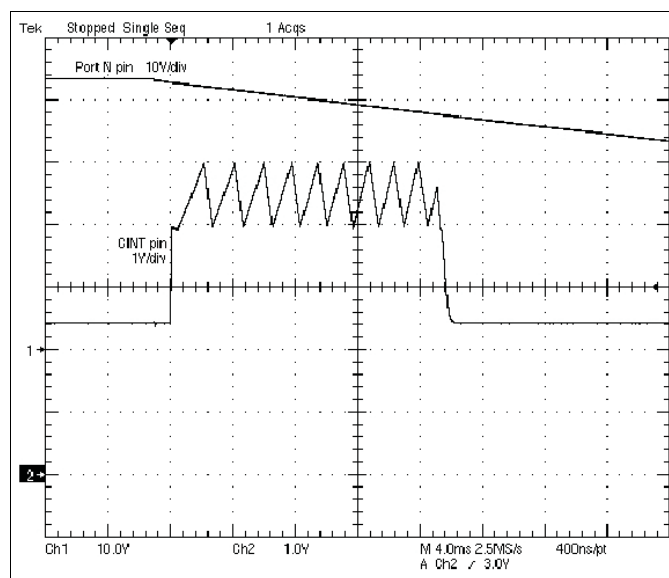


Figure 18. Legacy Detection Function Waveforms

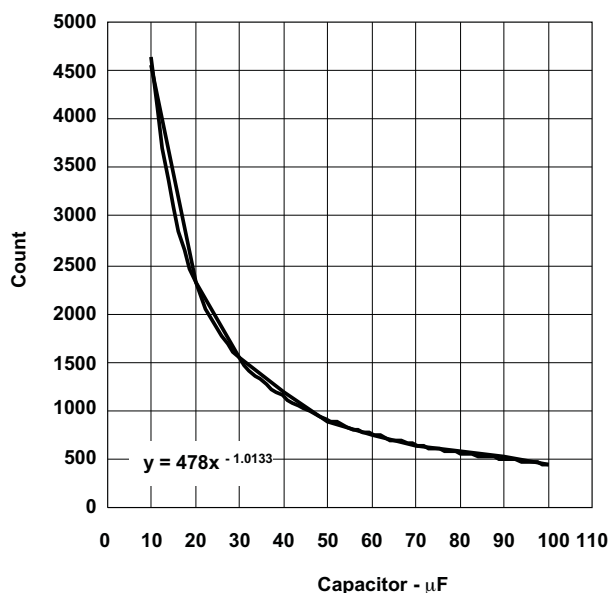
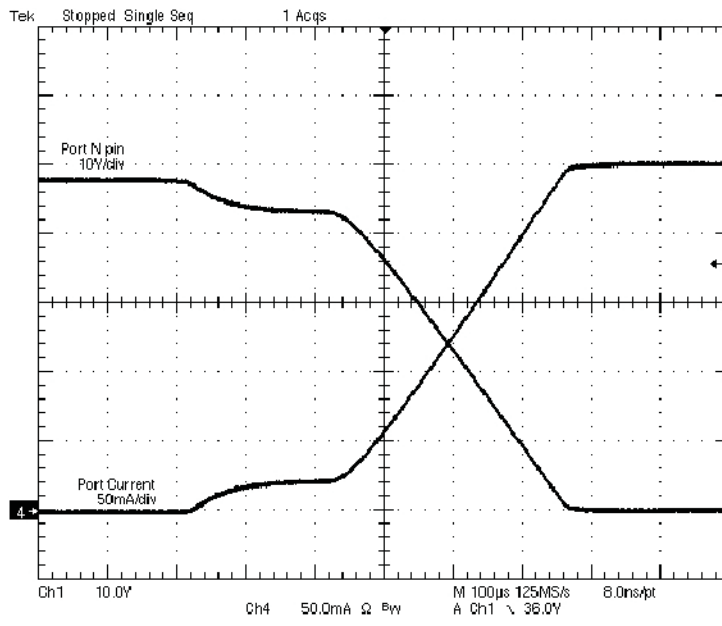


Figure 19. A/D Counts vs Legacy Port Capacitance

## Device Functional Modes (continued)

### 9.4.12 PMM Rup Pwr

PMM Rup Pwr function turns on the port power by ramping up the current that is being delivered to the load in a controlled fashion. The output current ramps from 0 mA to  $I_{LIM}$  (typically 425 mA) in approximately 500  $\mu$ s. Figure 20 shows the output voltage and current turning on for a 250-mA load.

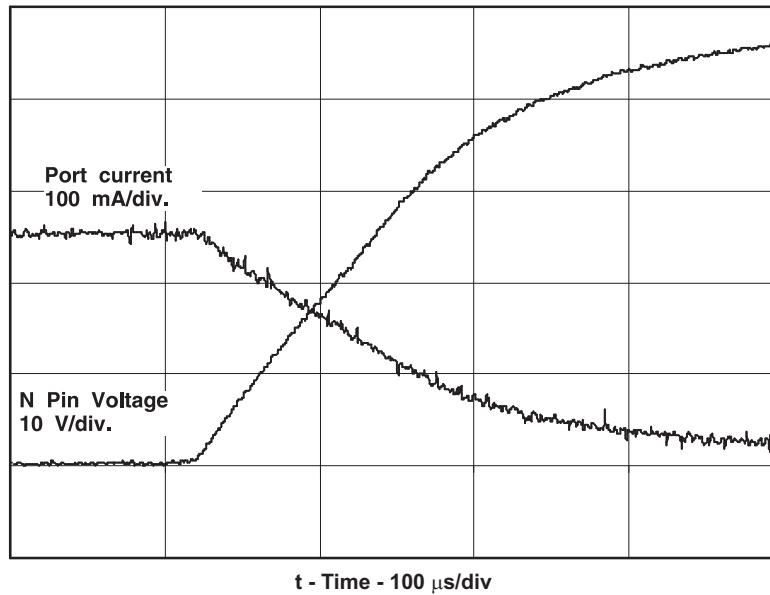


**Figure 20. Rup Pwr Function Waveforms**

## Device Functional Modes (continued)

### 9.4.13 PMM R<sub>DWN</sub>

PMM R<sub>DWN</sub> function turns off the port power by ramping down the current in a controlled fashion. The output current ramps from I<sub>LIM</sub> (typically 425 mA) to 0 mA in approximately 300  $\mu$ s. Figure 21 shows the output voltage and current shutting down for a 250-mA load.



**Figure 21. Rdwn Function Waveforms**

## 9.5 Programming

### 9.5.1 I<sup>2</sup>C Interface Description

The serial interface used in the TPS2384 is a standard 2-wire I<sup>2</sup>C slave architecture. The standard SDA line of the I<sup>2</sup>C architecture is broken out into independent input and output data paths. This feature simplifies earth grounded controller applications that require opto-isolators to keep the 48-V return of the Ethernet power system floating. For applications where opto-isolation is not required, the bidirectional property of the SDA line can be restored by connecting SDA\_I to SDA\_O. The SCL line is a unidirectional input only line as the TPS2384 is always accessed as a slave device and it never masters the bus.

Data transfers that require a data-flow reversal on the SDA line are 4-byte operations. This occurs during a TPS2384 port read cycle where a slave address byte is sent, followed by a port/register address byte write. A second slave address byte is sent followed by the data byte read using the port/register setup from the second byte in the sequence.

The I<sup>2</sup>C interface and the port read write registers are held in active reset until all input voltages are within specifications (V10, V6.3, V3.3 and V2.5) and the internal POR timer has timed out (see electrical specifications).

The I<sup>2</sup>C read cycle consists of the following steps 1 through 14 and is shown in [Figure 22](#):

1. Start Sequence (S)
2. Device address field
3. Write
4. Acknowledge
5. Register/Port address
6. Acknowledge
7. Stop
8. Start
9. Device address field
10. Read
11. Acknowledge
12. Data Transfer
13. Acknowledge
14. Stop

Data write transfers to the TPS2384 do not require a data-flow reversal and as such only a 3-byte operation is required. The sequence in this case would be to send a slave device address byte, followed by a write of the port/register address followed by a write of the data byte for the addressed port.

The I<sup>2</sup>C write cycle consists of the following steps 1 through 9 and is also shown in [Figure 22](#):

1. Start Sequence (S)
2. Device address field
3. Write
4. Acknowledge
5. Register/Port address
6. Acknowledge
7. Data for TPS2384
8. Acknowledge
9. Stop

## Programming (continued)

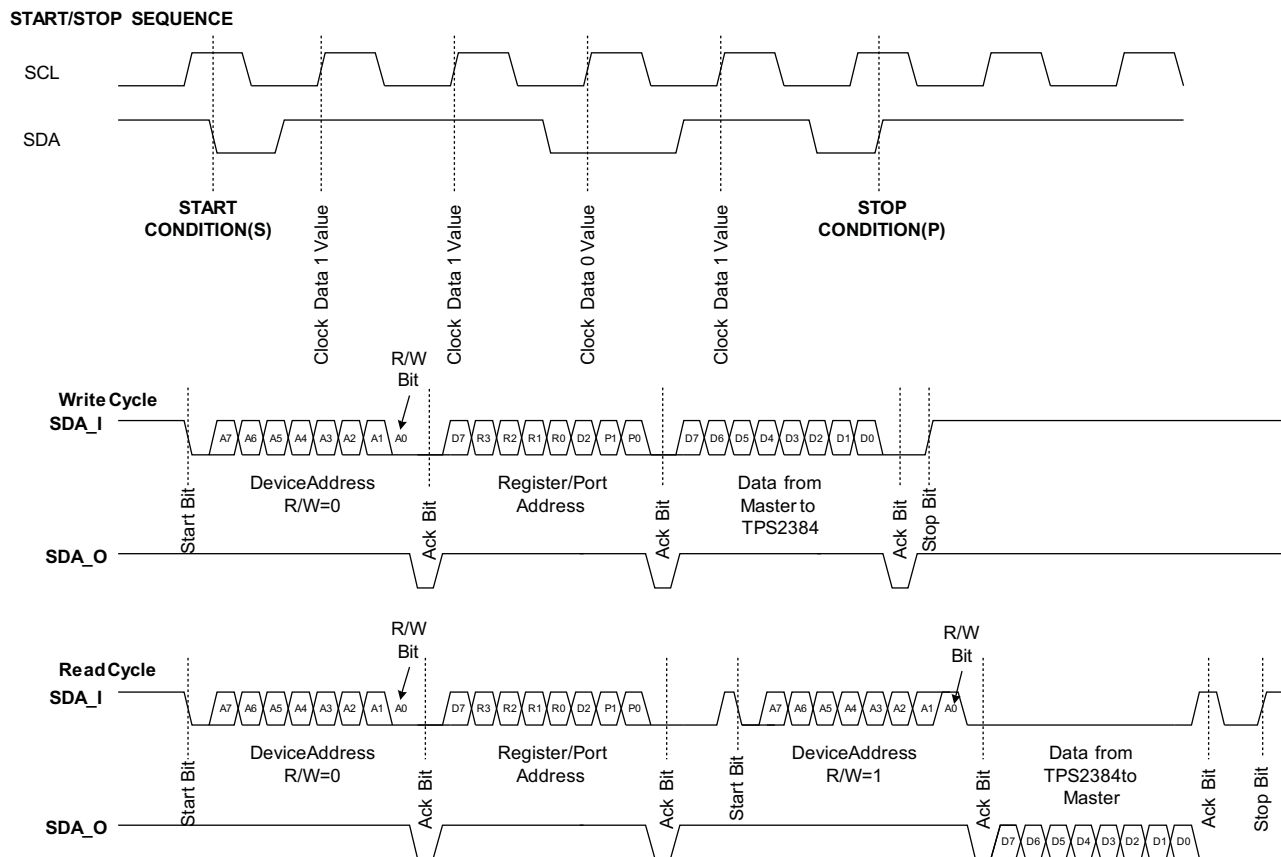
### 9.5.2 Start/Stop

The high-to-low transition of SDA\_I while SCL is high defines the start condition. The low to high transition of SDA\_I while SCL is high defines the stop condition. The master device initiates all start and stop conditions.

The first serial packet is enclosed within start and stop bits, consists of a 7-bit address field, read/write bit, and the acknowledge bit. The acknowledge bit is always generated by the device receiving the address or data field. Five of the seven address bits are used by the TPS2384. The value of the sixth and seventh bit is ignored. (See Note <sup>(1)</sup> in Table 1)

### 9.5.3 Chip Address

The address field of the TPS2384 is 8 bits long and contains 5 bits of device address select, a read/write bit, and two spare bits per Table 1. The five device address select bits follow this plan. These bits are compared against the hard-wired state of the corresponding device address select pins (A1–A5). When the field contents are equivalent to the pin logic states, the device is addressed. These bits are followed by LSB bit, which is used to set the read or write condition (1 for read and 0 for write). Following a start condition and an address field, the TPS2384 responds with an acknowledge by pulling the SDA\_O line low during the 9<sup>th</sup> clock cycle if the address field is equivalent to the value programmed by the pins. The SDA\_O line remains a stable low while the 9<sup>th</sup> clock pulse is high.



**Figure 22. I<sup>2</sup>C Read/Write Cycles**

- (1) TPS2384 will acknowledge four slave address values for each setting of A5-A1 (A7,A6 = 00, 01, 10, 11). Slave devices sharing the bus with TPS2384(s) should use unique A5-A1 values not matching those of the TPS2384(s).

## Programming (continued)

### 9.5.4 Chip Addressing

Table 1 shows the bit assignments during the addressing cycle.

**Table 1. Address Selection Field**

| BIT | FUNCTION                                             |
|-----|------------------------------------------------------|
| A7  | Future expansion (value not compared) <sup>(1)</sup> |
| A6  | Future expansion (value not compared) <sup>(1)</sup> |
| A5  | Device address. Compared with pin A5                 |
| A4  | Device address. Compared with pin A4                 |
| A3  | Device address. Compared with pin A3                 |
| A2  | Device address. Compared with pin A2                 |
| A1  | Device address LSB. Compared with pin A1             |
| A0  | Read/Write                                           |

- (1) TPS2384 will acknowledge four slave address values for each setting of A5-A1 (A7,A6 = 00, 01, 10, 11). Slave devices sharing the bus with TPS2384(s) should use unique A5-A1 values not matching those of the TPS2384(s).

### 9.5.5 Data Write Cycle

For a data write sequence, after the Port/Register address cycle, the TPS2384 accepts the eight bits of data as defined in the tables below. The data is latched into the previously selected Write Register, and the TPS2384 generates a data acknowledge pulse by pulling the SDA\_O line low for one clock cycle. Common register functions act on all ports simultaneously. Per port registers are specific to the target port only.

To reset the interface, the host or master subsequently generates a stop bit by releasing the SDA\_I line during the clock-high portion of an SCL pulse.

### 9.5.6 Port/Register Cycle

After the chip address cycle, the TPS2384 accepts eight bits of port/register select data as defined in Table 2. The SCL line high-to-low transition after the eighth data bit then latches the selection of the appropriate internal register for the follow-on data read or write operation. After latching the eight-bit data field, the TPS2384 pulls the SDA\_O line low for one clock cycle, for the acknowledge pulse.

### 9.5.7 Data Read Cycle

For a data read sequence, after the register acknowledge bit, the master device generates a stop condition. This is followed by a second start condition, and retransmitting the device address as described in chip address above. For this cycle, however, the R/W bit is set to a 1 to signal the read operation. The TPS2384 again responds with an acknowledge pulse. The address acknowledge is then followed by sequentially presenting each of the eight data bits on the SDA\_O line (MSB first), to be read by the host device on the rising edges of SCL. After eight bits are transmitted, the host acknowledges by pulling the SDA\_I line high for one clock pulse. The completed data transfer is terminated with the host generating a stop condition.

## 9.6 Register Maps

### 9.6.1 Register/Port Addressing Map

**Figure 23. Register/Port Addressing Map**

| 7      | 6                      | 5                        | 4                        | 3                      | 2      | 1                   | 0                   |
|--------|------------------------|--------------------------|--------------------------|------------------------|--------|---------------------|---------------------|
| Unused | Register select<br>MSB | Register select<br>Bit 2 | Register select<br>Bit 1 | Register select<br>LSB | Unused | Port address<br>MSB | Port address<br>LSB |
|        | R/W                    | R/W                      | R/W                      | R/W                    |        | R/W                 | R/W                 |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

**Table 2. Register/Port Addressing Map**

| Bit | Field                 | Type | Reset | Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              |
|-----|-----------------------|------|-------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| D7  | Unused                |      | 0     | 0                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        |
| D6  | Register select MSB   | R/W  | 0000  | 0000 = Common Read — Port fault status, chip ID and rev.<br>0001 = Common Control Write — Software reset, ports disable and AC Disc.<br>0010 = Port Control Write 1 — Function calls; misc. fault disables<br>0011 = Port Control Write 2 — Port enable; A/D control<br>0100 = Port Status Read 1 — Fault status; device Class info.<br>0101 = Port Status Read 2 — Function and other status<br>0110 = Discovery Current – Lower Bits — A/D resistance results<br>0111 = Discovery Current – Upper Bits — A/D resistance results<br>1000 = Voltage – Lower Bits – A/D voltage results<br>1001 = Voltage – Upper Bits — A/D voltage results<br>1010 = Current – Lower Bits — A/D current results<br>1011 = Current – Upper Bits — A/D current results<br>1100 = Temperature – Lower Bits — A/D temperature results<br>1101 = Temperature – Upper Bits — A/D temperature results<br>1110 = unused<br>1111 = Common Write – Test mode selections — timer disables, discovery control, etc. |
| D5  | Register select Bit 2 | R/W  |       |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          |
| D4  | Register select Bit 1 | R/W  |       |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          |
| D3  | Register select LSB   | R/W  |       |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          |
| D2  | Unused                |      | 0     | 0                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        |
| D1  | Port address MSB      | R/W  | 00    | 00 = port 1<br>01 = port 2<br>10 = port 3<br>11 = port 4                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 |
| D0  | Port address LSB      | R/W  |       |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          |

## 9.6.2 Common Read, Register Select

**Figure 24. Common Read, Register Select = 0000**

| 7                           | 6                           | 5                           | 4                           | 3        | 2 | 1       | 0 |
|-----------------------------|-----------------------------|-----------------------------|-----------------------------|----------|---|---------|---|
| Port 4 general Fault status | Port 3 general Fault status | Port 2 general Fault status | Port 1 general Fault status | Chip rev |   | Chip ID |   |
| R                           | R                           | R                           | R                           | R        |   | R       |   |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

**Table 3. Common Read, Register Select = 0000**

| Bit | Field                       | Type | Reset  | Description                                                       |
|-----|-----------------------------|------|--------|-------------------------------------------------------------------|
| D7  | Port 4 general Fault status | R    | 0      | 0 = no fault<br>1 = port fault <sup>(1)</sup> <sup>(2)</sup>      |
| D6  | Port 3 general Fault status | R    | 0      | 0 = no fault<br>1 = port fault <sup>(1)</sup> <sup>(2)</sup>      |
|     |                             | R    | 0      | 0 = no fault<br>1 = port fault <sup>(1)</sup> <sup>(2)</sup>      |
| D5  | Port 2 general Fault status | R    | 0      | 0 = no fault<br>1 = port fault <sup>(1)</sup> <sup>(2)</sup>      |
| D4  | Port 1 general Fault status | R    |        |                                                                   |
| D3  | Chip rev                    | R    | Varies | 00 = rev --<br>01 = rev 1<br>10 = rev 2<br>11 = rev 3             |
| D2  |                             |      |        |                                                                   |
| D1  | Chip ID                     | R    | 10     | 00 = TPS23841<br>01 = future use<br>10 = TPS2384<br>11 = reserved |
| D0  |                             |      |        |                                                                   |

(1) PMM faults cleared by Disable function.

(2) AM faults cleared by TED timer.

### 9.6.3 Common Write, Register Select = 1111 (Test Register)

**Figure 25. Common Write, Register Select = 1111 (Test Register)**

| 7      | 6                     | 5           | 4                | 3                 | 2                   | 1         | 0      |
|--------|-----------------------|-------------|------------------|-------------------|---------------------|-----------|--------|
| Unused | Thermal shutdown test | POR disable | Discovery timers | Discovery 1 and 2 | DC Disconnect timer | TED timer | Unused |
| R/W    | R/W                   | R/W         | R/W              | R/W               | R/W                 | R/W       |        |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

**Table 4. Common Write, Register Select = 1111 (Test Register)<sup>(1)</sup>**

| Bit | Field                 | Type | Reset | Description                                                                                                                                        |
|-----|-----------------------|------|-------|----------------------------------------------------------------------------------------------------------------------------------------------------|
| D7  | Unused                |      | 0     | 0                                                                                                                                                  |
| D6  | Thermal shutdown test | R/W  | 0     | 0 = normal operation<br>1 = force TSD condition (all ports off)                                                                                    |
| D5  | POR disable           | R/W  | 0     | 0 = normal POR timing<br>1 = force POR to a non-reset state                                                                                        |
| D4  | Discovery timers      | R/W  | 0     | 0 = normal (4-ms Discovery 1 and Discovery 2)<br>1 = timers disable                                                                                |
| D3  | Discovery 1 and 2     | R/W  | 0     | 0 = normal operation<br>1 = all 4-port Discovery 1 and Discovery 2 – halt                                                                          |
| D2  | DC Disconnect timer   | R/W  | 0     | 0 = DC Disconnect timer between 300 ms to 400 ms for loads less than 5 mA (IEEE standard)<br>1 = DC Disconnect timer 0 ms for loads less than 5 mA |
| D1  | TED timer             | R/W  | 0     | 0 = normal operation<br>1 = 750-ms TED timer disable                                                                                               |
| D0  | Unused                |      | 0     | 0                                                                                                                                                  |

(1) Test mode select; not intended for end--application use.

### 9.6.4 Common Control Write, Register Select = 0001

**Figure 26. Common Control Write, Register Select = 0001**

| 7      | 6      | 5                | 4       | 3      | 2                              | 1                 | 0              |
|--------|--------|------------------|---------|--------|--------------------------------|-------------------|----------------|
| Unused | Unused | Thermal shutdown | AC high | AC low | Port over/under voltage faults | All ports disable | Software RESET |
| R/W    | R/W    | R/W              | R/W     | R/W    | R/W                            | R/W               | R/W            |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

**Table 5. Common Control Write, Register Select = 0001**

| Bit | Field                                 | Type | Reset | Description                                                                 |
|-----|---------------------------------------|------|-------|-----------------------------------------------------------------------------|
| D7  | Unused                                |      | 0     | 0                                                                           |
| D6  | Unused                                |      | 0     | 0                                                                           |
| D5  | Thermal shutdown fault <sup>(1)</sup> | R/W  | 0     | 0 = active<br>1 = disable                                                   |
| D4  | AC high                               | R/W  | 0     | 0 = off<br>1 = AC_HI driver on                                              |
| D3  | AC low                                | R/W  | 0     | 0 = off<br>1 = AC_LO driver on                                              |
| D2  | Port over/under voltage faults        | R/W  | 0     | 0 = active<br>1 = disable                                                   |
| D1  | All ports disable <sup>(2)</sup>      | R/W  | 0     | 0 = normal operation<br>1 = all ports shut down (no ramp)                   |
| D0  | Software RESET                        | R/W  | 0     | 0 = normal operation<br>1 = reset all circuits and start a POR timing cycle |

(1) Register 0001, bit D5 operation inhibited after device probe.

(2) Refer to (SLUZ014) for Alternative B, semi-auto mode implementations which write to bit D1.

### 9.6.5 Port Control Write 1, Register Select = 0010 (One Per Port)

**Figure 27. Port Control Write 1, Register Select = 0010 (One Per Port)**

| 7      | 6      | 5                       | 4                     | 3              | 2              | 1              | 0              |
|--------|--------|-------------------------|-----------------------|----------------|----------------|----------------|----------------|
| Unused | Unused | Discovery fault disable | DC Disconnect disable | Function Bit 3 | Function Bit 2 | Function Bit 1 | Function Bit 0 |
|        |        | R/W                     | R/W                   | R/W            | R/W            | R/W            | R/W            |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

**Table 6. Port Control Write 1, Register Select = 0010 (One Per Port)**

| Bit | Field                   | Type | Reset | Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                       |
|-----|-------------------------|------|-------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| D7  | Unused                  |      | 0     | 0                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 |
| D6  | Unused                  |      | 0     | 0                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 |
| D5  | Discovery fault disable | R/W  | 0     | 0 = normal operation<br>1 = disable internal discovery fault limits (19 kΩ to 29.5 kΩ)                                                                                                                                                                                                                                                                                                                                                                                                                                                                                            |
| D4  | DC Disconnect disable   | R/W  | 0     | 0 = DC Disconnect active<br>1 = DC Disconnect disable (for AC Disconnect)                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         |
| D3  | Function Bit 3          | R/W  | 0000  | 0000 = Disable function (power down and reset all functions)<br>0001 = Discovery 1 function<br>0010 = Discovery 2 function<br>0011 = port voltage sample function (V sample)<br>0100 = legacy detection function<br>0101 = classification function<br>0110 = ramp up/power function (rup pwr)<br>0111 = continuous sample function (C sample)<br>1000 = ramp power down function (Rdwn)<br>1001 = ac low<br>1010 = ac high<br>1011 = port current sample function (I sample)<br>1100 = die temperature sample function (T sample)<br>1101 = spare<br>1110 = spare<br>1111 = spare |
| D2  | Function Bit 2          | R/W  |       |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                   |
| D1  | Function Bit 1          | R/W  |       |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                   |
| D0  | Function Bit 0          | R/W  |       |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                   |

### 9.6.6 Port Control Write 2, Register Select = 0011 (One Per Port)

**Figure 28. Port Control Write 2, Register Select = 0011 (One Per Port)**

| 7      | 6      | 5      | 4           | 3         | 2         | 1      | 0      |
|--------|--------|--------|-------------|-----------|-----------|--------|--------|
| Unused | Unused | Unused | Port Enable | A/D Start | A/D Abort | Unused | Unused |
|        |        |        | R/W         | R/W       | R/W       |        |        |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

**Table 7. Port Control Write 2, Register Select = 0011 (One Per Port)**

| Bit | Field                      | Type | Reset | Description                                 |
|-----|----------------------------|------|-------|---------------------------------------------|
| D7  | Unused                     |      | 0     | 0                                           |
| D6  | Unused                     |      | 0     | 0                                           |
| D5  | Unused                     |      | 0     | 0                                           |
| D4  | Port Enable <sup>(1)</sup> | R/W  | 0     | 0 = normal<br>1 = port disable              |
| D3  | A/D Start                  | R/W  | 0     | 0 = normal<br>1 = start A/D (self clearing) |
| D2  | A/D Abort                  | R/W  | 0     | 0 = normal<br>1 = abort                     |
| D1  | Unused                     |      | 0     | 0                                           |
| D0  | Unused                     |      | 0     | 0                                           |

(1) Refer to (SLUZ014) for Alternative B, semi-auto mode implementations which write to bit D4.

### 9.6.7 Port Status Read 1, Register Select = 0100 (One Per Port)

**Figure 29. Port Status Read 1, Register Select = 0100 (One Per Port)**

| 7                | 6                 | 5          | 4 | 3 | 2                  | 1            | 0                  |
|------------------|-------------------|------------|---|---|--------------------|--------------|--------------------|
| Discovery Status | Function Done Bit | Port Class |   |   | Fault status (MSB) | Fault status | Fault status (LSB) |
| R                | R                 | R          | R | R | R                  | R            | R                  |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

**Table 8. Port Status Read 1, Register Select = 0100 (One Per Port)**

| Bit | Field              | Type | Reset | Description                                                                                                                                                                                                                        |
|-----|--------------------|------|-------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| D7  | Discovery Status   | R    | 0     | 0 = normal<br>1 = discovery fail                                                                                                                                                                                                   |
| D6  | Function Done Bit  | R    | 0     | 0 = normal<br>1 = function complete (self clearing by a new function write)                                                                                                                                                        |
| D5  | Port Class         | R    | 000   | 000 = class 0<br>001 = class 1<br>010 = class 2<br>011 = class 3<br>100 = class 4                                                                                                                                                  |
| D4  | Port Class         | R    |       |                                                                                                                                                                                                                                    |
| D3  | Port Class         | R    |       |                                                                                                                                                                                                                                    |
| D2  | Fault status (MSB) | R    | 000   | 000 = no faults<br>001 = UV/OV fault<br>010 = thermal shutdown fault (TSD)<br>011 = overload current > 50-ms fault<br>100 = load disconnect<br>101 = reserved for future<br>110 = reserved for future<br>111 = reserved for future |
| D1  | Fault status       | R    |       |                                                                                                                                                                                                                                    |
| D0  | Fault status (LSB) | R    |       |                                                                                                                                                                                                                                    |

### 9.6.8 Port Status Read 2, Register Select = 0101 (One Per Port)

**Figure 30. Port Status Read 2, Register Select = 0101 (One Per Port)**

| 7      | 6      | 5      | 4               | 3          | 2                     | 1               | 0                     |
|--------|--------|--------|-----------------|------------|-----------------------|-----------------|-----------------------|
| Unused | Unused | Unused | Watch dog timer | A/D status | Function status (MSB) | Function status | Function status (LSB) |
|        |        |        | R               | R          | R                     | R               | R                     |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

**Table 9. Port Status Read 2, Register Select = 0101 (One Per Port)**

| Bit | Field                 | Type | Reset | Description                                                                                                                                       |
|-----|-----------------------|------|-------|---------------------------------------------------------------------------------------------------------------------------------------------------|
| D7  |                       |      | 0     | 0                                                                                                                                                 |
| D6  | Unused                |      | 0     | 0                                                                                                                                                 |
| D5  | Unused                |      | 0     | 0                                                                                                                                                 |
| D4  | Watch dog timer       | R    | 0     | 0 = not active<br>1 = active                                                                                                                      |
| D3  | A/D status            | R    | 0     | 0 = not active<br>1 = active (conversion in process)                                                                                              |
| D2  | Function status (MSB) | R    | 000   | 000 = disabled<br>001 = searching<br>010 = power delivery<br>011 = fault<br>100 = test<br>101 = other fault<br>110 = undefined<br>111 = undefined |
| D1  | Function status       | R    |       |                                                                                                                                                   |
| D0  | Function status (LSB) | R    |       |                                                                                                                                                   |

## 9.6.9 A/D Results Registers (Discovery Current, Voltage, Current and Temperature)

### 9.6.9.1 Discovery Current — Lower Bits, Register Select = 0110 (One Per Port)

**Figure 31. Discovery Current — Lower Bits, Register Select = 0110 (One Per Port)**

| 7         | 6         | 5         | 4         | 3         | 2         | 1         | 0         |
|-----------|-----------|-----------|-----------|-----------|-----------|-----------|-----------|
| A/D bit 7 | A/D bit 6 | A/D bit 5 | A/D bit 4 | A/D bit 3 | A/D bit 2 | A/D bit 1 | A/D bit 0 |
| R         | R         | R         | R         | R         | R         | R         | R         |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

**Table 10. Discovery Current — Lower Bits, Register Select = 0110 (One Per Port)**

| Bit | Field     | Type | Reset | Description    |
|-----|-----------|------|-------|----------------|
| D7  | A/D bit 7 | R    | 0     | A/D lower bits |
| D6  | A/D bit 6 | R    |       |                |
| D5  | A/D bit 5 | R    |       |                |
| D4  | A/D bit 4 | R    |       |                |
| D3  | A/D bit 3 | R    |       |                |
| D2  | A/D bit 2 | R    |       |                |
| D1  | A/D bit 1 | R    |       |                |
| D0  | A/D bit 0 | R    |       |                |

### 9.6.9.2 Discovery Current — Upper Bits, Register Select = 0111 (One Per Port)

**Figure 32. Discovery Current — Upper Bits, Register Select = 0111 (One Per Port)**

| 7                             | 6          | 5          | 4          | 3          | 2          | 1         | 0         |
|-------------------------------|------------|------------|------------|------------|------------|-----------|-----------|
| Resistor measurement complete | A/D bit 14 | A/D bit 13 | A/D bit 12 | A/D bit 11 | A/D bit 10 | A/D bit 9 | A/D bit 8 |
| R                             | R          | R          | R          | R          | R          | R         | R         |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

**Table 11. Discovery Current — Upper Bits, Register Select = 0111 (One Per Port)**

| Bit | Field                         | Type | Reset | Description                                                                                                                                                                         |
|-----|-------------------------------|------|-------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| D7  | Resistor measurement complete | R    | 0     | 0 = measurement active (bit set low at the start of Discovery 1 or Discovery 2)<br>1 = measurement complete (bit set high after A/D is completed during Discovery 1 or Discovery 2) |
| D6  | A/D bit 14                    | R    | 0     | A/D upper bits                                                                                                                                                                      |
| D5  | A/D bit 13                    | R    |       |                                                                                                                                                                                     |
| D4  | A/D bit 12                    | R    |       |                                                                                                                                                                                     |
| D3  | A/D bit 11                    | R    |       |                                                                                                                                                                                     |
| D2  | A/D bit 10                    | R    |       |                                                                                                                                                                                     |
| D1  | A/D bit 9                     | R    |       |                                                                                                                                                                                     |
| D0  | A/D bit 8                     | R    |       |                                                                                                                                                                                     |

### 9.6.9.3 Voltage — Lower Bits, Register Select = 1000 (One Per Port)

**Figure 33. Voltage — Lower Bits, Register Select = 1000 (One Per Port)**

| 7         | 6         | 5         | 4         | 3         | 2         | 1         | 0         |
|-----------|-----------|-----------|-----------|-----------|-----------|-----------|-----------|
| A/D bit 7 | A/D bit 6 | A/D bit 5 | A/D bit 4 | A/D bit 3 | A/D bit 2 | A/D bit 1 | A/D bit 0 |
| R         | R         | R         | R         | R         | R         | R         | R         |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

**Table 12. Voltage — Lower Bits, Register Select = 1000 (One Per Port)**

| Bit | Field     | Type | Reset | Description    |
|-----|-----------|------|-------|----------------|
| D7  | A/D bit 7 | R    | 0     | A/D lower bits |
| D6  | A/D bit 6 | R    |       |                |
| D5  | A/D bit 5 | R    |       |                |
| D4  | A/D bit 4 | R    |       |                |
| D3  | A/D bit 3 | R    |       |                |
| D2  | A/D bit 2 | R    |       |                |
| D1  | A/D bit 1 | R    |       |                |
| D0  | A/D bit 0 | R    |       |                |

### 9.6.9.4 Voltage — Upper Bits, Register Select = 1001 (One Per Port)

**Figure 34. Voltage — Upper Bits, Register Select = 1001 (One Per Port)**

| 7                            | 6          | 5          | 4          | 3          | 2          | 1         | 0         |
|------------------------------|------------|------------|------------|------------|------------|-----------|-----------|
| Voltage measurement complete | A/D bit 14 | A/D bit 13 | A/D bit 12 | A/D bit 11 | A/D bit 10 | A/D bit 9 | A/D bit 8 |
| R                            | R          | R          | R          | R          | R          | R         | R         |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

**Table 13. Voltage — Upper Bits, Register Select = 1001 (One Per Port)**

| Bit | Field                        | Type | Reset | Description                                                                                                                                                         |
|-----|------------------------------|------|-------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| D7  | Voltage measurement complete | R    | 0     | 0 = measurement active (bit set low when A/D begins a voltage measurement)<br>1 = measurement complete (bit set high after A/D has completed a voltage measurement) |
| D6  | A/D bit 14                   | R    | 0     | A/D upper bits                                                                                                                                                      |
| D5  | A/D bit 13                   | R    |       |                                                                                                                                                                     |
| D4  | A/D bit 12                   | R    |       |                                                                                                                                                                     |
| D3  | A/D bit 11                   | R    |       |                                                                                                                                                                     |
| D2  | A/D bit 10                   | R    |       |                                                                                                                                                                     |
| D1  | A/D bit 9                    | R    |       |                                                                                                                                                                     |
| D0  | A/D bit 8                    | R    |       |                                                                                                                                                                     |

### 9.6.9.5 Current — Lower Bits, Register Select = 1010 (One Per Port)

**Figure 35. Current — Lower Bits, Register Select = 1010 (One Per Port)**

| 7         | 6         | 5         | 4         | 3         | 2         | 1         | 0         |
|-----------|-----------|-----------|-----------|-----------|-----------|-----------|-----------|
| A/D bit 7 | A/D bit 6 | A/D bit 5 | A/D bit 4 | A/D bit 3 | A/D bit 2 | A/D bit 1 | A/D bit 0 |
| R         | R         | R         | R         | R         | R         | R         | R         |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

**Table 14. Current — Lower Bits, Register Select = 1010 (One Per Port)**

| Bit | Field     | Type | Reset | Description    |
|-----|-----------|------|-------|----------------|
| D7  | A/D bit 7 | R    | 0     | A/D lower bits |
| D6  | A/D bit 6 | R    |       |                |
| D5  | A/D bit 5 | R    |       |                |
| D4  | A/D bit 4 | R    |       |                |
| D3  | A/D bit 3 | R    |       |                |
| D2  | A/D bit 2 | R    |       |                |
| D1  | A/D bit 1 | R    |       |                |
| D0  | A/D bit 0 | R    |       |                |

### 9.6.9.6 Current — Upper Bits, Register Select = 1011 (One Per Port)

**Figure 36. Current — Upper Bits, Register Select = 1011 (One Per Port)**

| 7                            | 6          | 5          | 4          | 3          | 2          | 1         | 0         |
|------------------------------|------------|------------|------------|------------|------------|-----------|-----------|
| Current measurement complete | A/D bit 14 | A/D bit 13 | A/D bit 12 | A/D bit 11 | A/D bit 10 | A/D bit 9 | A/D bit 8 |
| R                            | R          | R          | R          | R          | R          | R         | R         |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

**Table 15. Current — Upper Bits, Register Select = 1011 (One Per Port)**

| Bit | Field                        | Type | Reset | Description                                                                                                                                                         |
|-----|------------------------------|------|-------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| D7  | Current measurement complete | R    | 0     | 0 = measurement active (bit set low when A/D begins a current measurement)<br>1 = measurement complete (bit set high after A/D has completed a current measurement) |
| D6  | A/D bit 14                   | R    | 0     |                                                                                                                                                                     |
| D5  | A/D bit 13                   | R    |       |                                                                                                                                                                     |
| D4  | A/D bit 12                   | R    |       |                                                                                                                                                                     |
| D3  | A/D bit 11                   | R    |       |                                                                                                                                                                     |
| D2  | A/D bit 10                   | R    |       |                                                                                                                                                                     |
| D1  | A/D bit 9                    | R    |       |                                                                                                                                                                     |
| D0  | A/D bit 8                    | R    |       |                                                                                                                                                                     |

### 9.6.9.7 Temperature — Lower Bits, Register Select = 1100 (One Per Port)

**Figure 37. Temperature — Lower Bits, Register Select = 1100 (One Per Port)**

| 7         | 6         | 5         | 4         | 3         | 2         | 1         | 0         |
|-----------|-----------|-----------|-----------|-----------|-----------|-----------|-----------|
| A/D bit 7 | A/D bit 6 | A/D bit 5 | A/D bit 4 | A/D bit 3 | A/D bit 2 | A/D bit 1 | A/D bit 0 |
| R         | R         | R         | R         | R         | R         | R         | R         |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

**Table 16. Temperature — Lower Bits, Register Select = 1100 (One Per Port)**

| Bit | Field     | Type | Reset | Description    |
|-----|-----------|------|-------|----------------|
| D7  | A/D bit 7 | R    | 0     | A/D lower bits |
| D6  | A/D bit 6 | R    | 0     |                |
| D5  | A/D bit 5 | R    | 0     |                |
| D4  | A/D bit 4 | R    | 0     |                |
| D3  | A/D bit 3 | R    | 0     |                |
| D2  | A/D bit 2 | R    | 0     |                |
| D1  | A/D bit 1 | R    | 0     |                |
| D0  | A/D bit 0 | R    | 0     |                |

### 9.6.9.8 Temperature — Upper Bits, Register Select = 1101 (One Per Port)

**Figure 38. Temperature — Upper Bits, Register Select = 1101 (One Per Port)**

| 7                                | 6          | 5          | 4          | 3          | 2          | 1         | 0         |
|----------------------------------|------------|------------|------------|------------|------------|-----------|-----------|
| Temperature measurement complete | A/D bit 14 | A/D bit 13 | A/D bit 12 | A/D bit 11 | A/D bit 10 | A/D bit 9 | A/D bit 8 |
| R                                | R          | R          | R          | R          | R          | R         | R         |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

**Table 17. Temperature — Upper Bits, Register Select = 1101 (One Per Port)**

| Bit | Field                            | Type | Reset | Description                                                                                                                                                                 |
|-----|----------------------------------|------|-------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| D7  | Temperature measurement complete | R    | 0     | 0 = measurement active (bit set low when A/D begins a temperature measurement)<br>1 = measurement complete (bit set high after A/D has completed a temperature measurement) |
| D6  | A/D bit 14                       | R    | 0     | A/D upper bits                                                                                                                                                              |
| D5  | A/D bit 13                       | R    |       |                                                                                                                                                                             |
| D4  | A/D bit 12                       | R    |       |                                                                                                                                                                             |
| D3  | A/D bit 11                       | R    |       |                                                                                                                                                                             |
| D2  | A/D bit 10                       | R    |       |                                                                                                                                                                             |
| D1  | A/D bit 9                        | R    |       |                                                                                                                                                                             |
| D0  | A/D bit 8                        | R    |       |                                                                                                                                                                             |

## 10 Application and Implementation

### NOTE

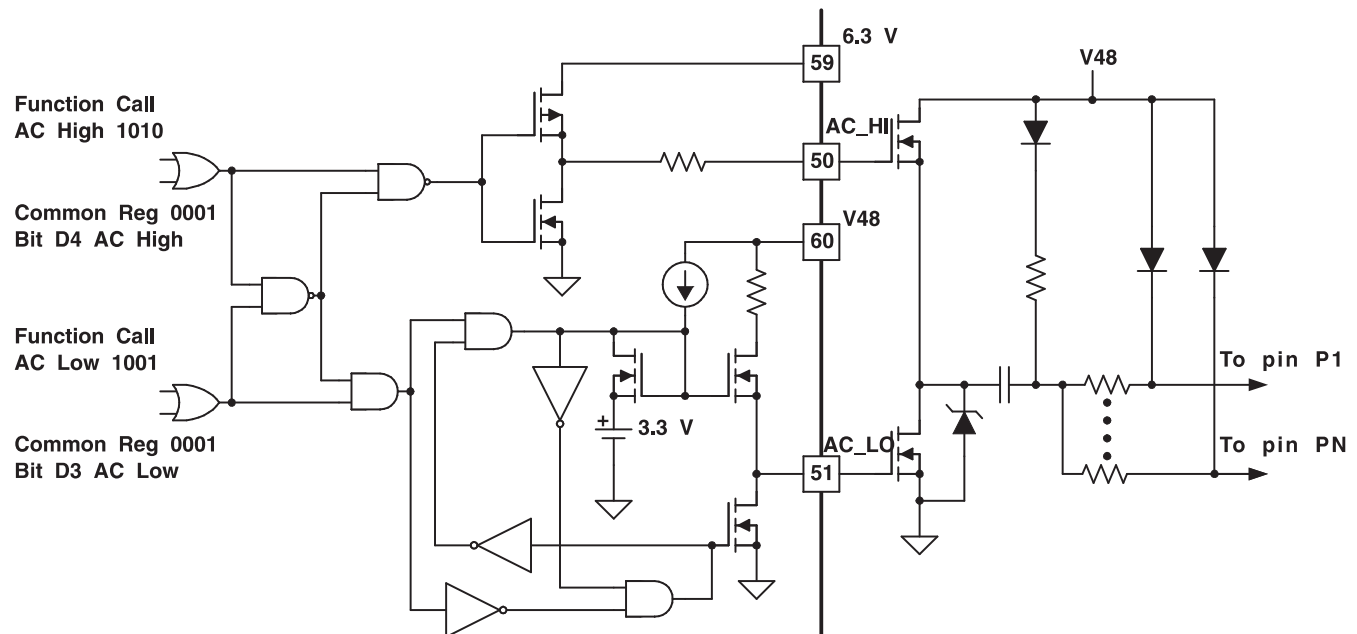
Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

### 10.1 Application Information

The TPS2384 is a quad-port PSEPM can be used in simple, low port count, automatic or high port count micro-controller managed applications.

#### 10.1.1 AC Disconnect Drive Circuit Detail

TPS2384 AC\_HI and AC\_LO can be used with the port generator drive circuit shown in [Figure 39](#) for up to 16 ports. Detailed component specifications can be found in the TPS2384EVM User Guide, ([SLVU126](#)).



**Figure 39. AC\_HI and LOW Without External FET Configurations**

#### 10.1.2 Connection of Unused Ports and Pins

The TPS2384 can be used on applications needing only 1 to 4 ports. For unused ports follow the guidelines shown in ([SLVA231](#)).

#### 10.1.3 Opto-isolator Interface

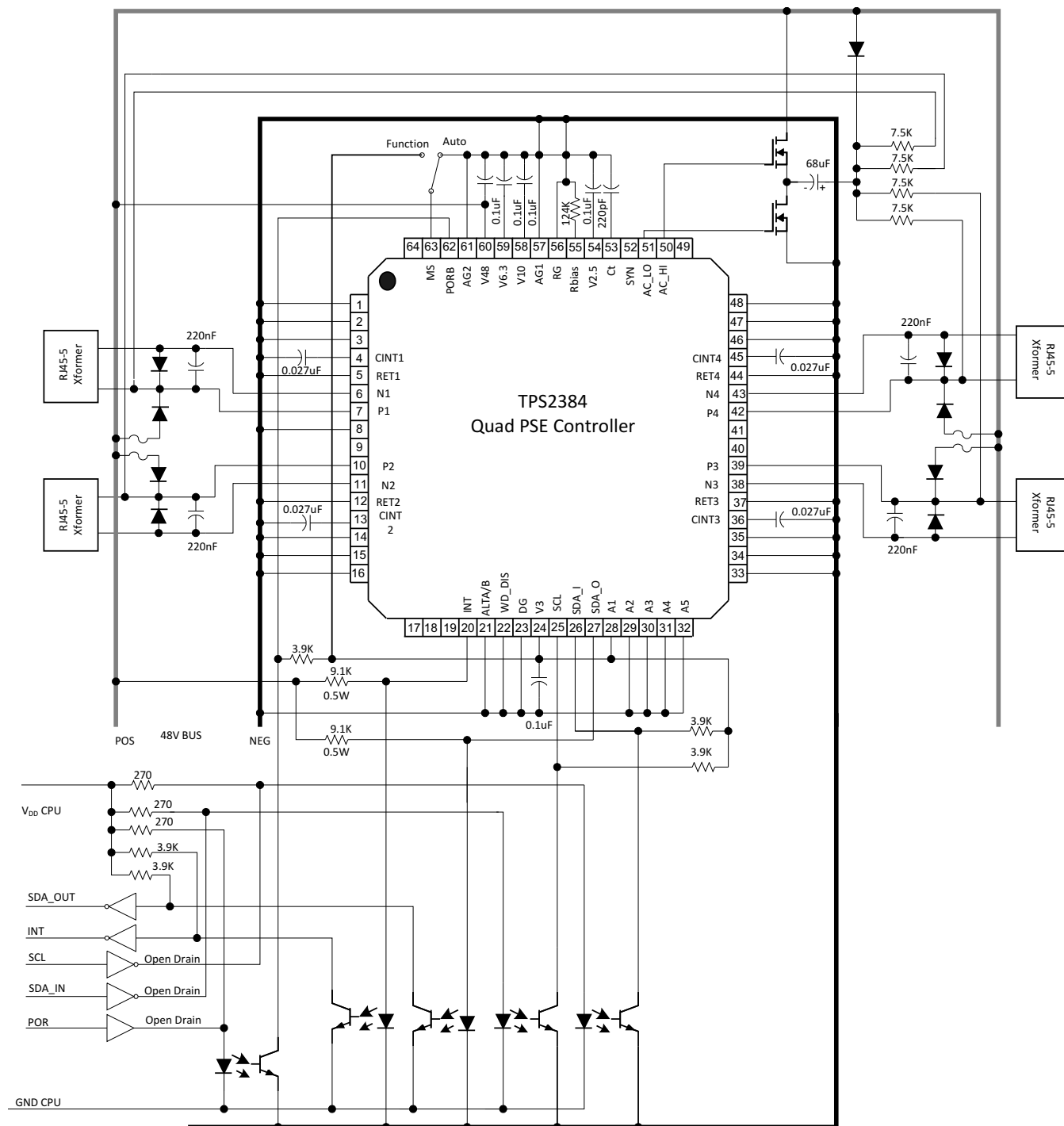
The TPS2384 can be used in applications requiring digital isolation of the I<sup>2</sup>C signals. The detailed design procedure and component selection can be found in ([SLVA229](#)).

#### 10.1.4 Port Protection from Electrical Transients

Detailed design procedure and component selection for electrical transient protection of ports can be found in ([SLVA233](#)).

## 10.2 Typical Application

This section provides a typical application example for a four port PSE system. The detailed schematic for a basic 4 PORT (PMM) isolated configuration with AC Disconnect is shown in [Figure 40](#) (PAP pinout shown).



**Figure 40. Basic 4 PORT (PMM) Isolated Configuration with AC Disconnect**

## Typical Application (continued)

### 10.2.1 Design Requirements

For this design example, use the parameters shown in [Table 18](#).

**Table 18. Design Parameters**

| PARAMETER          | VALUE                                   |
|--------------------|-----------------------------------------|
| Input voltage      | 48 V $\pm$ 3 V                          |
| Input current      | 1.52 A $\pm$ 0.1 A (fully loaded ports) |
| Number of ports    | 4                                       |
| Other requirements | AC Disconnect Detection                 |

### 10.2.2 Detailed Design Procedure

#### 10.2.2.1 Power Pin Bypass Capacitors

- V48: Connect a 0.1 $\mu$ F, 100V, X7R ceramic capacitor from V48 to AG1 as close to the device as possible.
- V10: Connect a 0.1 $\mu$ F, 25V, X7R ceramic capacitor from V10 to AG1 as close to the device as possible.
- V6.3: Connect a 0.1 $\mu$ F, 10V, X7R ceramic capacitor from V6.3 to AG1 as close to the device as possible.
- V3.3: Connect a 0.1 $\mu$ F, 10V, X7R ceramic capacitor from V3.3 to DG as close to the device as possible.
- V2.5: Connect a 0.1 $\mu$ F, 10V, X7R ceramic capacitor from V2.5 to RG as close to the device as possible.

#### 10.2.2.2 Per Port Components

- Port capacitor: Connect a 220 nF – 470 nF, 100 V, X7R ceramic capacitor from Px to Nx.
- Fuse: The port fuse should be a slow blow type rated for at least 60 VDC and 1 A. A resettable Polyfuse may also be used.
- Protection Diodes: The port TVS should be rated for the expected port surge environment. The TVS should have a minimum reverse standoff voltage of 58 V and a maximum clamping voltage of 95 V at the expected peak surge current. The negative clamp diode should be rated for  $V_R = 100$  V minimum and be able to survive the expected negative surge current. Low forward voltage drop at the rated current is essential.
- Integration capacitor: Connect a 0.027  $\mu$ F, 16 V minimum, polycarbonate, poly-propylene, polystyrene, teflon, or other low leakage capacitor from CINTx to RG as close to the device as possible.

#### 10.2.2.3 Bias and Timing

- Bias resistor: Connect a 124 k $\Omega$ , 1/16W, 1% chip resistor from RBIAS to RG as close to the device as possible.
- Timing Capacitor: Connect a 220 pF, 25 V, COG, 2% ceramic capacitor from CT to RG as close to the device as possible.

## 10.2.3 Application Curves

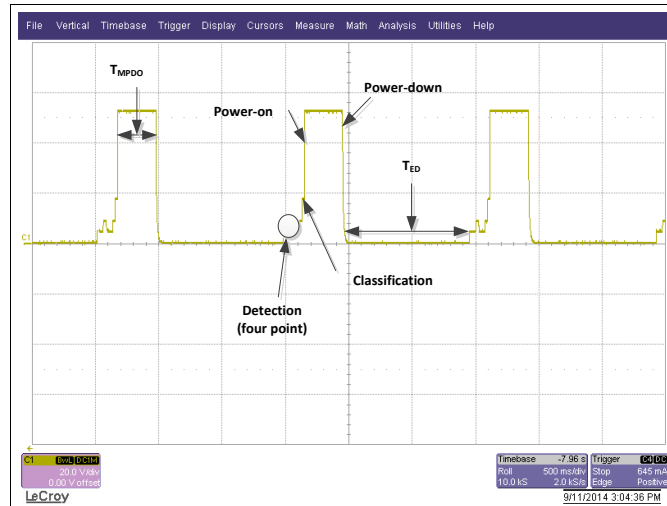


Figure 41. Good Detect, Class, Power-on, Followed by Under-current Disconnect

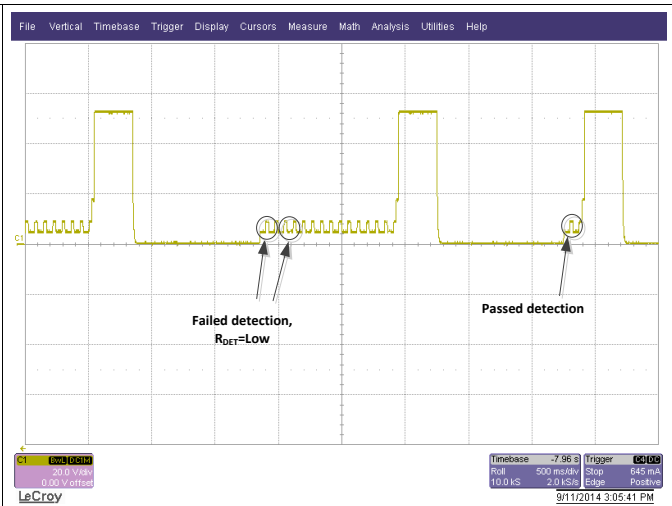


Figure 42. Marginal Detect, Class, Power-on Followed by Under-current Disconnect

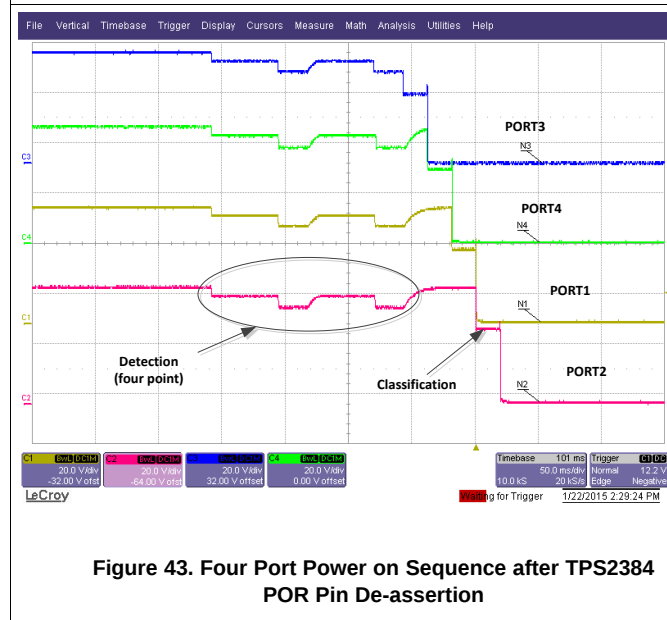


Figure 43. Four Port Power on Sequence after TPS2384 POR Pin De-assertion

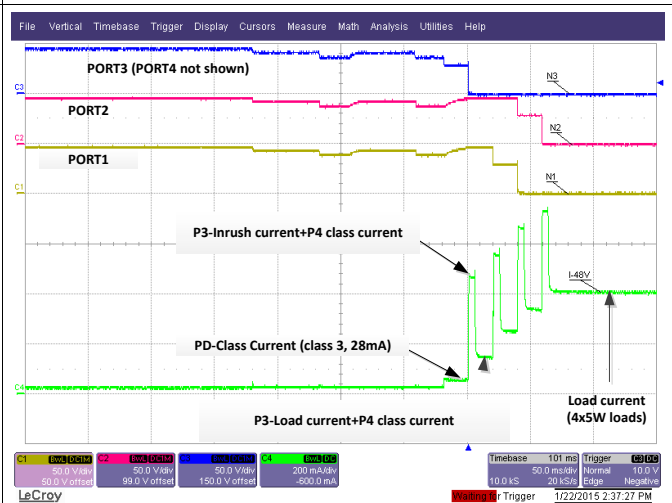


Figure 44. 48-V Supply Current During Four Port Start Up Sequence (After POR Pin De-assertion)

## 11 Power Supply Recommendations

The recommended V48 supply voltage requirement is 44 V to 57 V. A power supply with a nominal 48-V output can support type 1 PD requirements. The output current required from the V48 supply depends on the number of ports required in the system. ICUT for a type 1 port is 375 mA  $\pm$  25 mA. Size the V48 supply accordingly for the number of ports to be supported.

The V3.3 digital supply can be used externally for light loads less than 3 mA.

## 12 Layout

### 12.1 Layout Guidelines

#### 12.1.1 Local Circuits

- V48: Place the V48 capacitor from V48 to AG1 as close to the device as possible.
- V10: Place the V10 capacitor from V10 to AG1 as close to the device as possible.
- V6.3: Place the V6.3 capacitor from V6.3 to AG1 as close to the device as possible.
- V3.3: Place the V3.3 capacitor from V3.3 to DG as close to the device as possible.
- V2.5: Place the V2.5 capacitor from V2.5 to RG as close to the device as possible.
- RBIAS: Place the RBIAS resistor from RBIAS to RG on PCB topside as close to the device as possible.
- CT: Place the CT capacitor from CT to RG on PCB topside as close to the device as possible.
- CINTx: Place the CINTx capacitors from CINTx to RG on PCB topside as close to the device as possible.

#### 12.1.2 System Protection Circuits

These circuits will include the per-port capacitor, fuse, protection diodes, common mode filtering (ferrite beads or chokes), Bob Smith terminations and AC disconnect generator components. Detailed layout and placement guidelines can be found in [SLVA233](#).

### 12.2 Layout Example

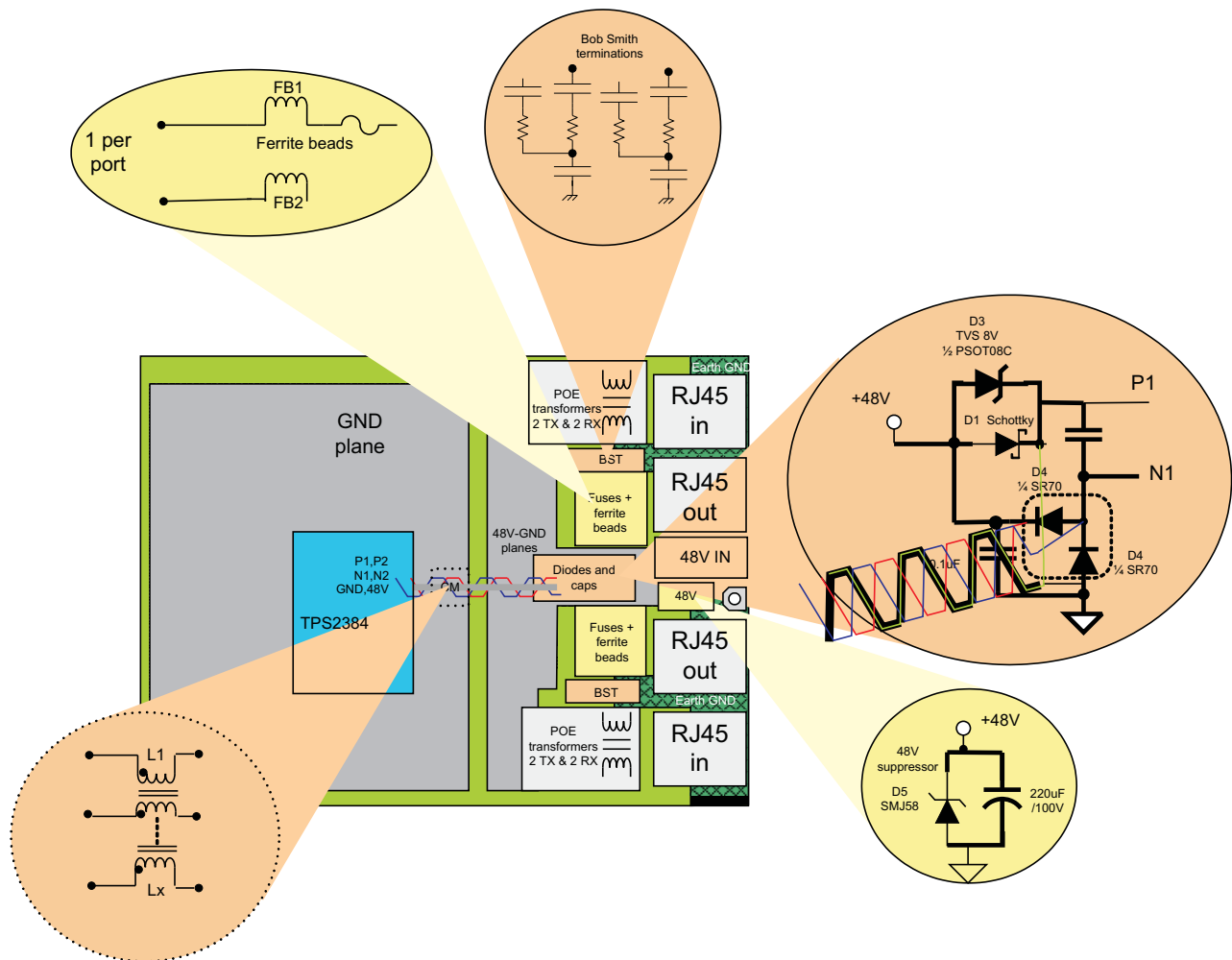


Figure 45. Layout

## 12.3 Thermal Consideration

Ensure proper thermal management of TPS2384 by following the example board layout guidelines provided in the [Mechanical, Packaging, and Orderable Information](#) section.

## 13 Device and Documentation Support

### 13.1 Documentation Support

#### 13.1.1 Related Documentation

*Opto-Isolator Selection Guidelines: TPS2384 I2C Interface*, [SLVA229](#)

*Proper Termination of Unused Port Connections*, [SLVA231](#)

*Electrical Transient Immunity for Power-over-Ethernet (PoE)*, [SLVA233](#)

*TPS2384 Power Sourcing Equipment Power Manager Device*, [SLUZ014](#)

### 13.2 Trademarks

PowerPAD is a trademark of Texas Instruments.

All other trademarks are the property of their respective owners.

### 13.3 Electrostatic Discharge Caution



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

### 13.4 Glossary

[SLYZ022](#) — *TI Glossary*.

This glossary lists and explains terms, acronyms, and definitions.

## 14 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

## PACKAGING INFORMATION

| Orderable Device | Status<br>(1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan<br>(2)            | Lead/Ball Finish<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5) | Samples                 |
|------------------|---------------|--------------|--------------------|------|----------------|----------------------------|-------------------------|----------------------|--------------|-------------------------|-------------------------|
| TPS2384PAP       | ACTIVE        | HTQFP        | PAP                | 64   | 160            | Green (RoHS<br>& no Sb/Br) | NIPDAU                  | Level-3-260C-168 HR  | -40 to 125   | TPS2384PAP              | <a href="#">Samples</a> |
| TPS2384PAPG4     | ACTIVE        | HTQFP        | PAP                | 64   | 160            | Green (RoHS<br>& no Sb/Br) | NIPDAU                  | Level-3-260C-168 HR  | -40 to 125   | TPS2384PAP              | <a href="#">Samples</a> |
| TPS2384PAPR      | ACTIVE        | HTQFP        | PAP                | 64   | 1000           | Green (RoHS<br>& no Sb/Br) | NIPDAU                  | Level-3-260C-168 HR  | -40 to 125   | TPS2384PAP              | <a href="#">Samples</a> |
| TPS2384PAPRG4    | ACTIVE        | HTQFP        | PAP                | 64   | 1000           | Green (RoHS<br>& no Sb/Br) | NIPDAU                  | Level-3-260C-168 HR  | -40 to 125   | TPS2384PAP              | <a href="#">Samples</a> |
| TPS2384PJD       | ACTIVE        | HTQFP        | PJD                | 64   | 160            | Green (RoHS<br>& no Sb/Br) | NIPDAU                  | Level-3-260C-168 HR  | -40 to 125   | TPS2384PJD              | <a href="#">Samples</a> |
| TPS2384PJDR      | ACTIVE        | HTQFP        | PJD                | 64   | 1000           | Green (RoHS<br>& no Sb/Br) | NIPDAU                  | Level-3-260C-168 HR  | -40 to 125   | TPS2384PJD              | <a href="#">Samples</a> |

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

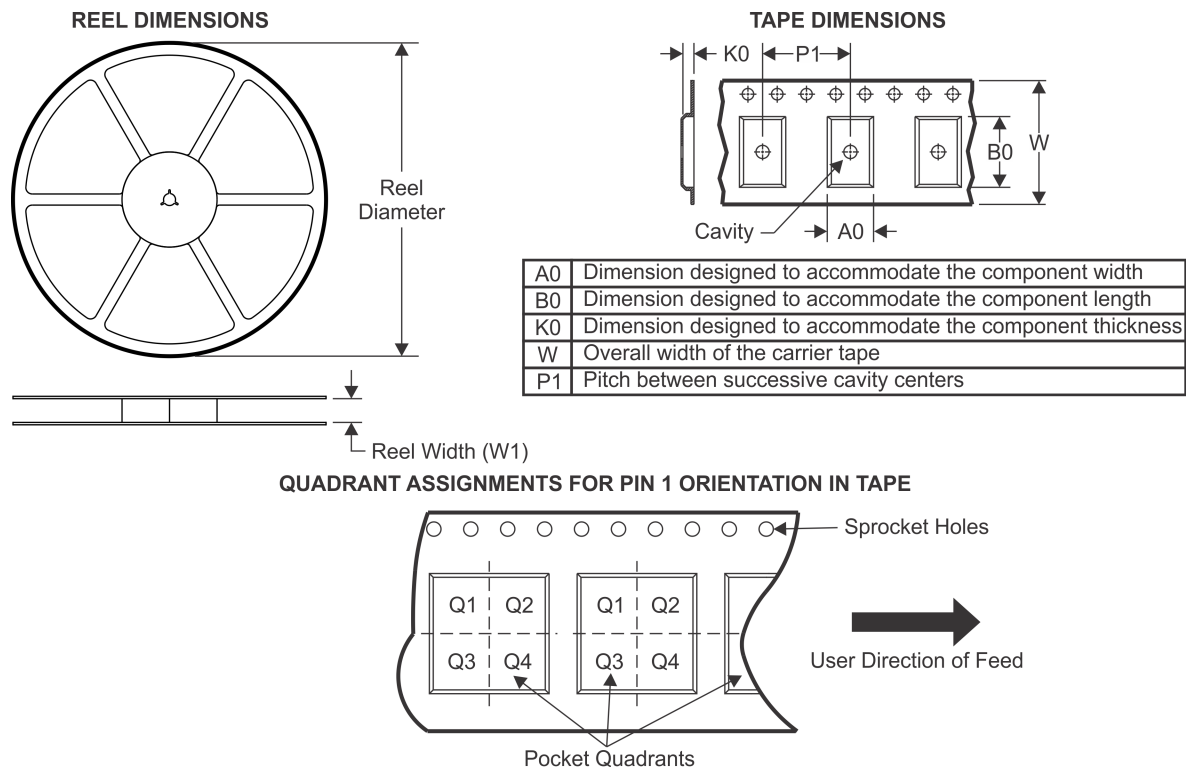
(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "-" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

<sup>(6)</sup> Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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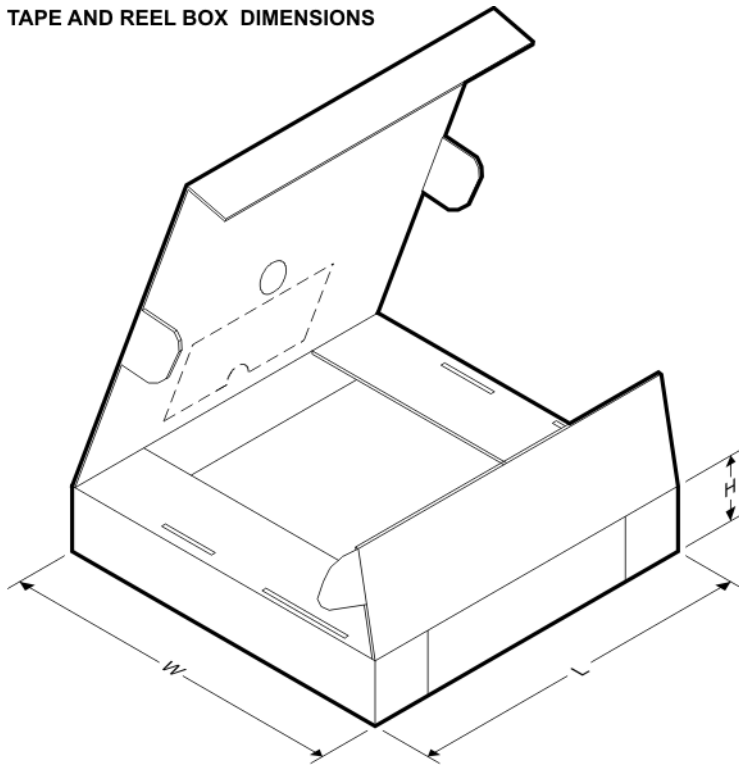
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**TAPE AND REEL INFORMATION**


\*All dimensions are nominal

| Device      | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|-------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| TPS2384PAPR | HTQFP        | PAP             | 64   | 1000 | 330.0              | 24.4               | 13.0    | 13.0    | 1.5     | 16.0    | 24.0   | Q2            |
| TPS2384PJDR | HTQFP        | PJD             | 64   | 1000 | 330.0              | 24.4               | 13.0    | 13.0    | 1.5     | 16.0    | 24.0   | Q2            |

## TAPE AND REEL BOX DIMENSIONS

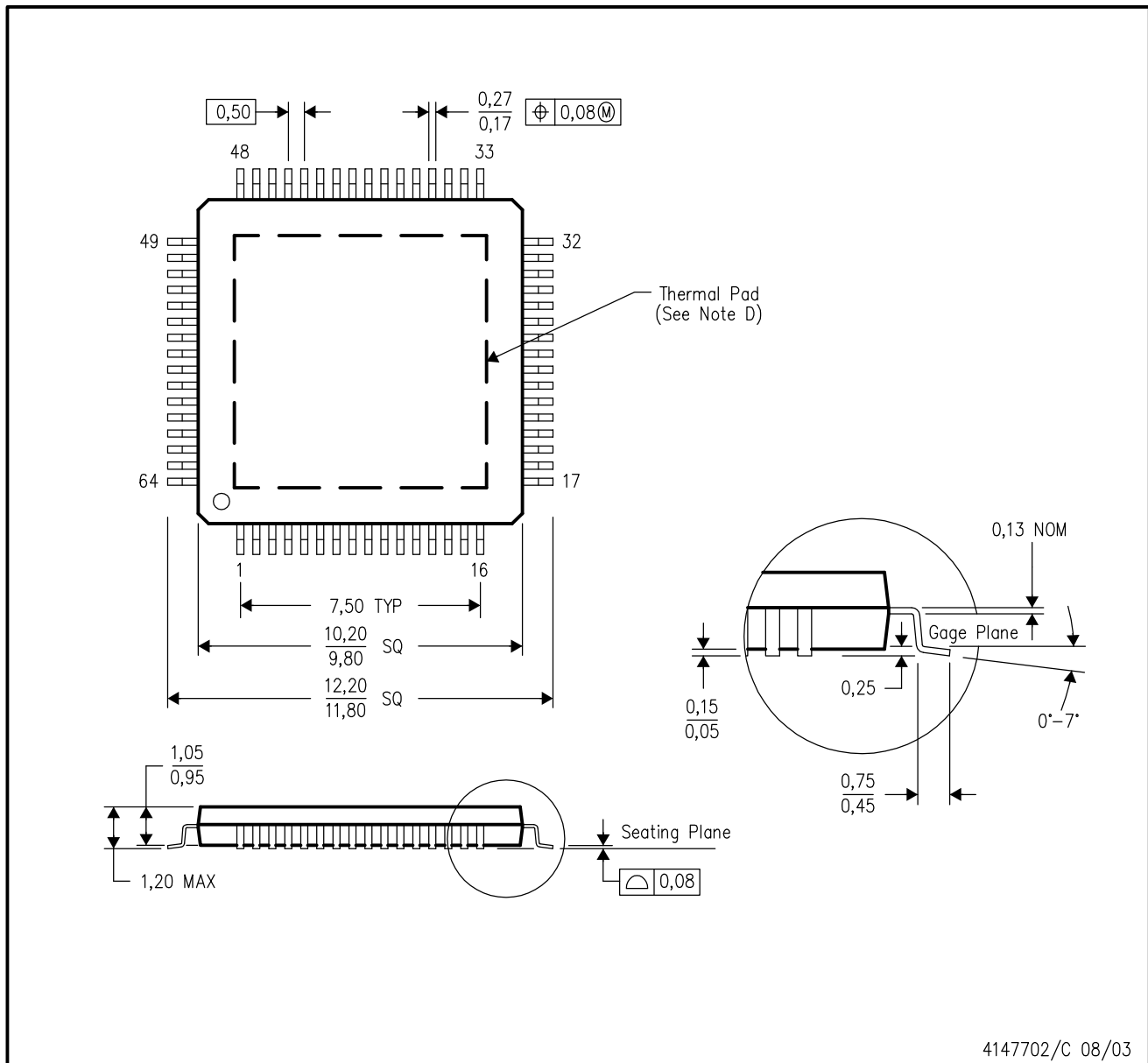


\*All dimensions are nominal

| Device      | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|-------------|--------------|-----------------|------|------|-------------|------------|-------------|
| TPS2384PAPR | HTQFP        | PAP             | 64   | 1000 | 350.0       | 350.0      | 43.0        |
| TPS2384PJDR | HTQFP        | PJD             | 64   | 1000 | 350.0       | 350.0      | 43.0        |

PAP (S-PQFP-G64)

PowerPAD™ PLASTIC QUAD FLATPACK



- NOTES:
- All linear dimensions are in millimeters.
  - This drawing is subject to change without notice.
  - Body dimensions do not include mold flash or protrusion.
  - This package is designed to be soldered to a thermal pad on the board. Refer to Technical Brief, PowerPad Thermally Enhanced Package, Texas Instruments Literature No. SLMA002 for information regarding recommended board layout. This document is available at [www.ti.com](http://www.ti.com) <<http://www.ti.com>>.
  - Falls within JEDEC MS-026

PowerPAD is a trademark of Texas Instruments.

## THERMAL PAD MECHANICAL DATA

PAP (S-PQFP-G64)

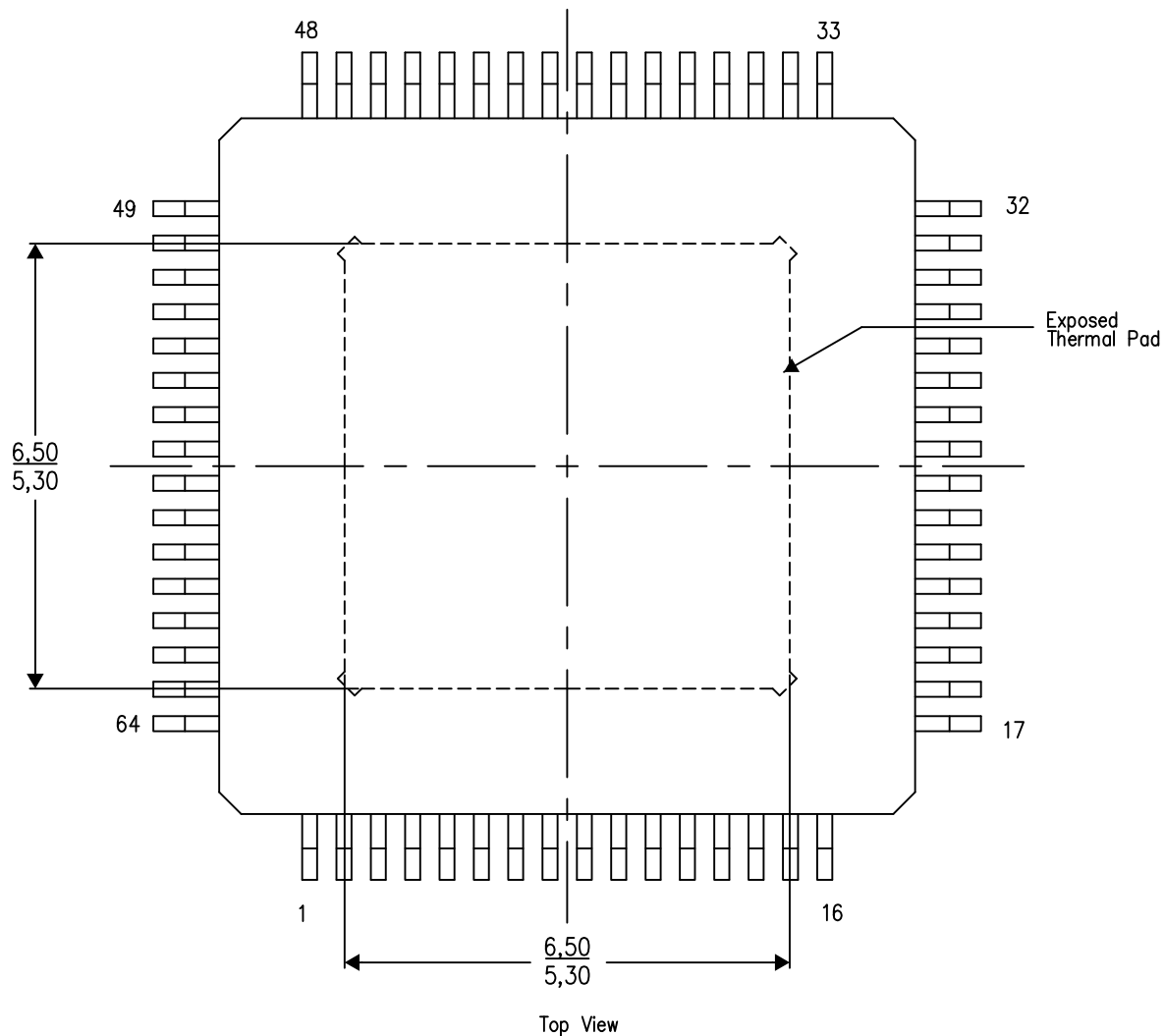
PowerPAD™ PLASTIC QUAD FLATPACK

### THERMAL INFORMATION

This PowerPAD™ package incorporates an exposed thermal pad that is designed to be attached to a printed circuit board (PCB). The thermal pad must be soldered directly to the PCB. After soldering, the PCB can be used as a heatsink. In addition, through the use of thermal vias, the thermal pad can be attached directly to the appropriate copper plane shown in the electrical schematic for the device, or alternatively, can be attached to a special heatsink structure designed into the PCB. This design optimizes the heat transfer from the integrated circuit (IC).

For additional information on the PowerPAD package and how to take advantage of its heat dissipating abilities, refer to Technical Brief, PowerPAD Thermally Enhanced Package, Texas Instruments Literature No. SLMA002 and Application Brief, PowerPAD Made Easy, Texas Instruments Literature No. SLMA004. Both documents are available at [www.ti.com](http://www.ti.com).

The exposed thermal pad dimensions for this package are shown in the following illustration.



Exposed Thermal Pad Dimensions

4206326-4/P 05/14

NOTES: A. All linear dimensions are in millimeters

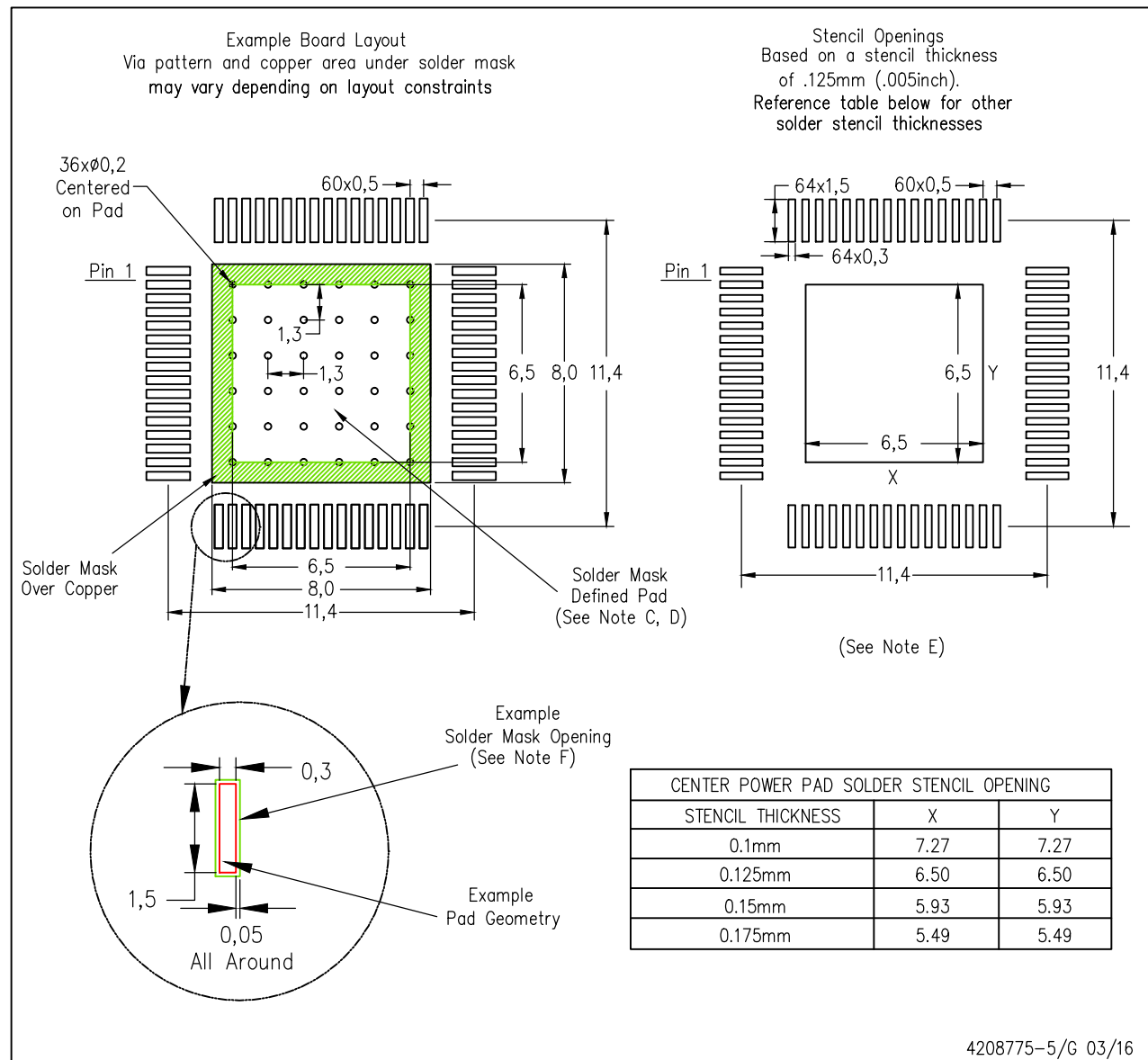
 Tie strap features may not be present.

PowerPAD is a trademark of Texas Instruments

# LAND PATTERN DATA

PAP (S-PQFP-G64)

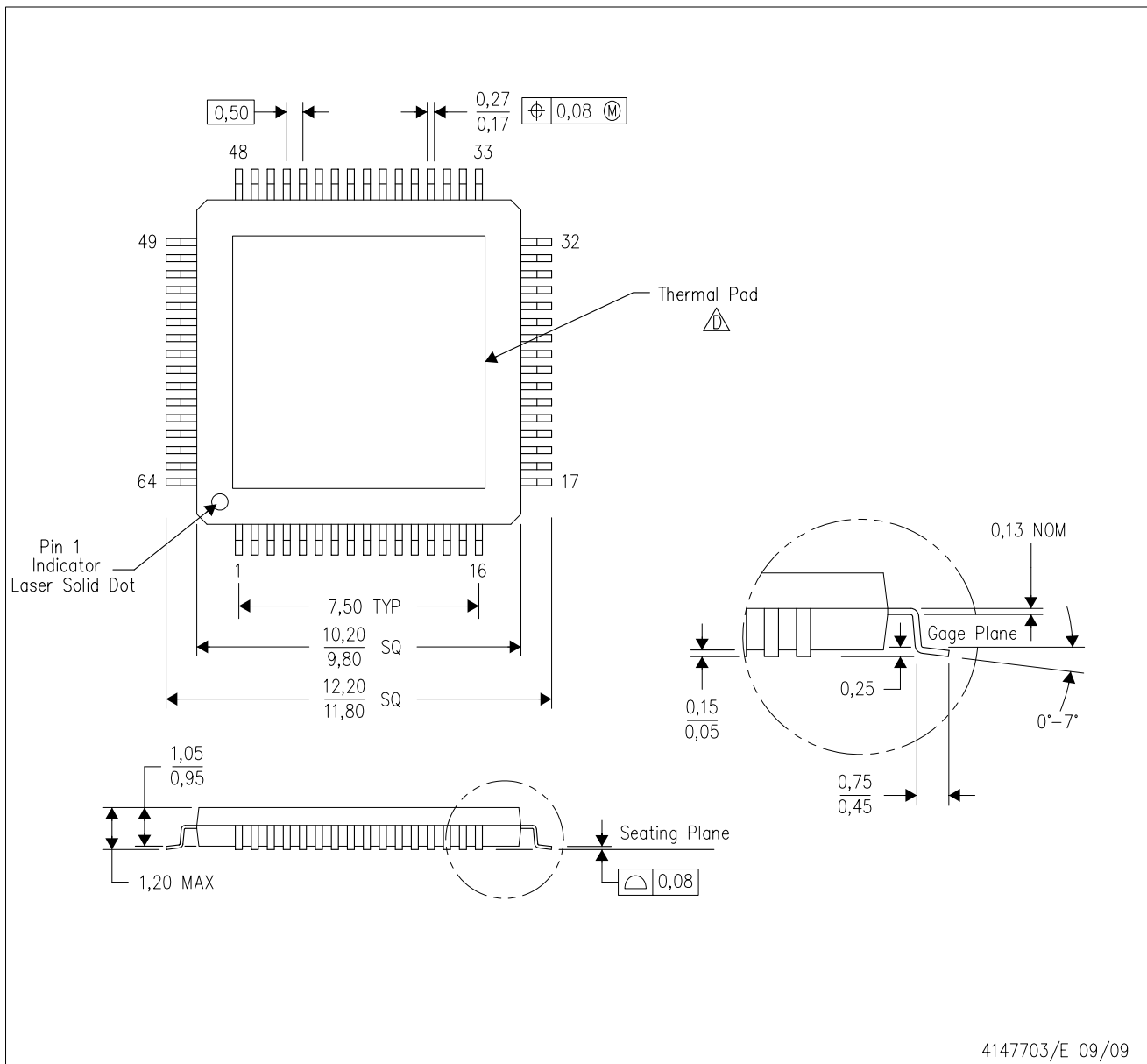
PowerPAD™ PLASTIC QUAD FLATPACK



- NOTES:
- All linear dimensions are in millimeters.
  - This drawing is subject to change without notice.
  - Customers should place a note on the circuit board fabrication drawing not to alter the center solder mask defined pad.
  - This package is designed to be soldered to a thermal pad on the board. Refer to Technical Brief, PowerPad Thermally Enhanced Package, Texas Instruments Literature No. SLMA002, SLMA004, and also the Product Data Sheets for specific thermal information, via requirements, and recommended board layout. These documents are available at [www.ti.com](http://www.ti.com) <<http://www.ti.com>>. Publication IPC-7351 is recommended for alternate designs.
  - Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Example stencil design based on a 50% volumetric metal load solder paste. Refer to IPC-7525 for other stencil recommendations.
  - Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

PowerPAD is a trademark of Texas Instruments

## PJD (S-PQFP-G64) PowerPAD™ PLASTIC QUAD FLATPACK (DIE DOWN)



- NOTES:
- A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
  - B. This drawing is subject to change without notice.
  - C. Body dimensions do not include mold flash or protrusion.
  - D. Refer to Technical Brief, PowerPad Thermally Enhanced Package, Texas Instruments Literature No. SLMA002 for information regarding recommended board layout. This document is available at [www.ti.com](http://www.ti.com) <<http://www.ti.com>>. See the product data sheet for details regarding the exposed thermal pad dimensions.
  - E. Falls within JEDEC MS-026

## THERMAL PAD MECHANICAL DATA

PJD (S-PQFP-G64)

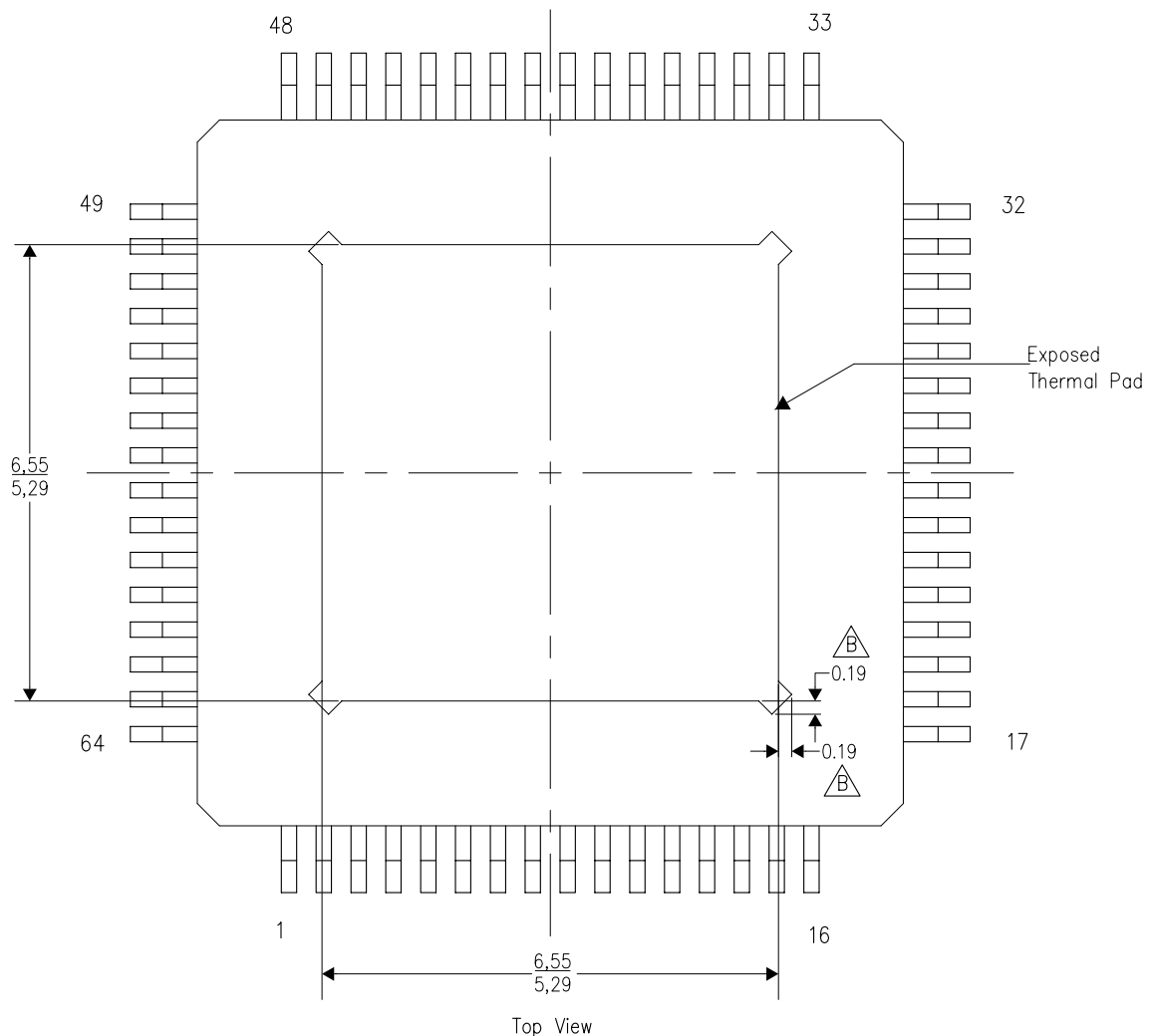
PowerPAD™ PLASTIC QUAD FLATPACK

### THERMAL INFORMATION

This PowerPAD™ package incorporates an exposed thermal pad that is designed to be attached directly to an external heatsink. This design optimizes the heat transfer from the integrated circuit (IC).

For additional information on the PowerPAD package and how to take advantage of its heat dissipating abilities, refer to Technical Brief, PowerPAD Thermally Enhanced Package, Texas Instruments Literature No. SLMA002 and Application Brief, PowerPAD Made Easy, Texas Instruments Literature No. SLMA004. Both documents are available at [www.ti.com](http://www.ti.com).

The exposed thermal pad dimensions for this package are shown in the following illustration.



4206330-4/B 10/10

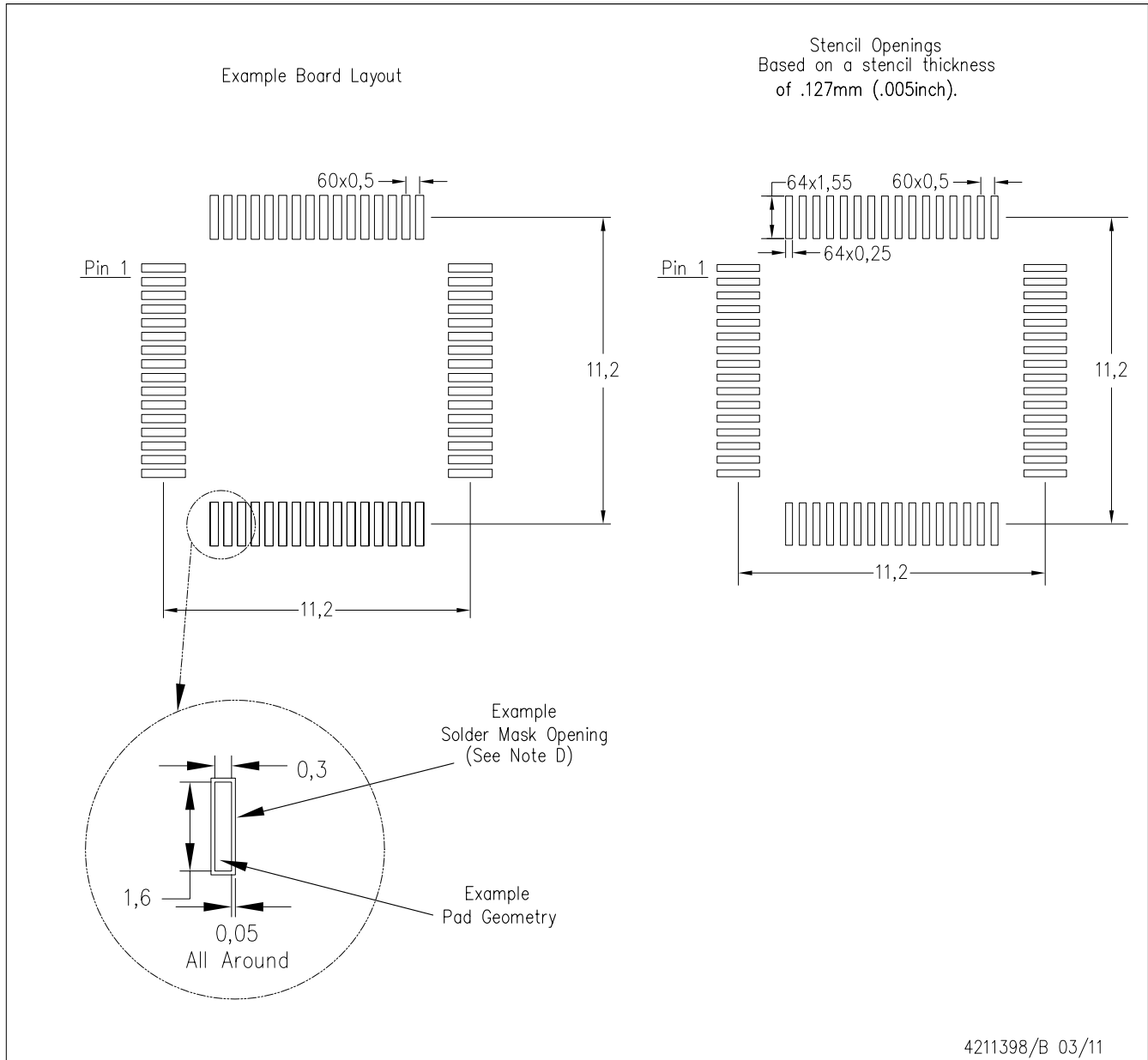
NOTE: A. All linear dimensions are in millimeters

 Tie strap features may not be present.

PowerPAD is a trademark of Texas Instruments

PJD (S-PQFP-G64)

PowerPAD™ PLASTIC QUAD FLATPACK



- NOTES:
- All linear dimensions are in millimeters.
  - This drawing is subject to change without notice.
  - Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Example stencil design based on a 50% volumetric metal load solder paste. Refer to IPC-7525 for other stencil recommendations.
  - Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

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Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265  
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